Overview

9 Other Stim Desktop 1 2 3 4 4 8 7 6 5

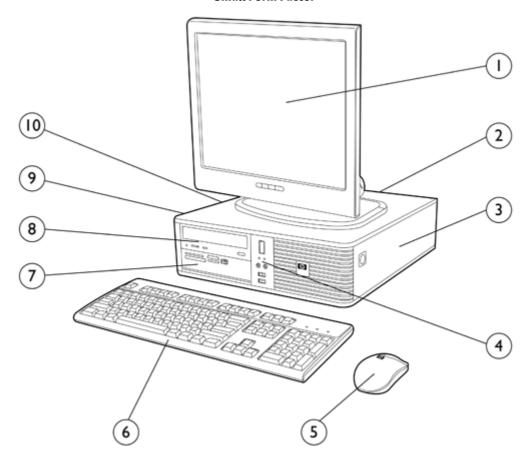
- 1. Rear I/O: (6) USB 2.0, (1) DisplayPort, (2) PS/2, (1) RJ-45, (1) VGA port, (1) audio in, (1) audio out
- 2. (1) 2.5" internal hard disk drive bay
- 3. Front I/O: (2) USB 2.0, headphone and microphone
- 4. 135W 87% efficient external power adapter
- 5. Tower stand (sold separately)

- 6. (1) Optical disk drive (slimline)
- 7. HP 2-button optical scroll mouse
- 8. HP keyboard
- 9. HP Monitor (sold separately)



Overview

Small Form Factor



- 1. HP Monitor (sold separately)
- 2. Rear I/O: (6) USB 2.0, (1) serial port, (2) PS/2, (1) RJ-45, (1) VGA 7. port, (1) DisplayPort, (1) audio in, (1) audio out

Optional: 2nd serial port, (1) parallel port, (1) eSATA port

- (1) low profile PCI slot, (1) low profile PCI Express x1 slot, (2)
 low profile PCI Express x16 slots
 (NOTE: 2nd x16 slot has x4 connectivity.)
- 4. Front I/O: (2) USB 2.0, headphone and microphone

HP 2-button optical scroll mouse

(1) Optical disk drive

HP keyboard

9. (1) 3.5-inch internal drive bay supporting primary hard disk

(1) 3.5-inch external drive bay supporting media card reader,

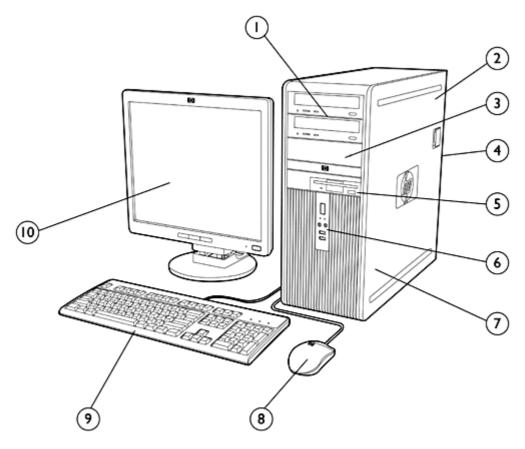
10. 240-watt standard efficiency power supply

diskette drive, or secondary hard disk drive

Optional: 85% efficient energy saving power supply

Overview

Convertible Minitower



- (2) Optical disk drives
 (2) 3.5" internal hard disk drive bays
- 365-watt standard efficiency power supply, Active Power Factor Correction (PFC)

Optional: 85% efficient energy saving power supply

- 3. (1) 5.25" removable media drive bay
- 4. Rear I/O: (6) USB 2.0, (1) serial port, (2) PS/2, (1) RJ-45, (1) VGA, (1) DisplayPort, (1) audio in, (1) audio out

Optional: 2nd serial port, (1) parallel port, (1) eSATA port

5. Media card reader or Floppy disk drive

- 6. Front I/O: (2) USB 2.0, headphone and microphone
- 7. (3) full-height PCI slots, (1) full-height PCI Express x1 slot, (2) full-height PCI Express x16 slots (NOTE: 2nd x16 slot has x4 connectivity.)
- 8. HP 2-button optical scroll mouse
- 9. HP keyboard
- 10. HP Monitor (sold separately)



Overview

At A Glance

- Designed for long-term deployment within commercial and institutional organizations
- Guaranteed lengthy purchase lifecycles and image stability
- Integrated dual independent monitor support via both a VGA and DisplayPort monitor interface
- Optional 85% efficient power supplies
- ENERGY STAR qualification for dc7900e models
- Intel® Q45 Express chipset featuring Intel's Graphics Media Accelerator 4500
- Software image fully compatible across all models and form factors
- BIOS developed and engineered by HP for better security, manageability and software image stability
- Created using industry leading Design for Environment standards
- Supports industry standard management protocols including DASH, Intel Standard Manageability, and Intel Core 2 Processor with vPro Technology (on select models)
- CMT and SFF models can be configured with multiple hard disk drives in a RAID array
- Selected configurations with global availability easily set up and ordered through HP.com Business to Business portals (http://h10019.www1.hp.com/business-site/index.html)
- Tailored HP Factory Express deployment and lifecycle services available (http://h71028.www7.hp.com/enterprise/cache/97688-0-0-225-121.aspx)
- Protected by HP Services, including standard warranties up to 5-5-5 (terms and conditions vary by country; certain restrictions and exclusions apply)
- Tool-less serviceability features for easier upgrades and repairs
- Choice of professional chassis form factors to accommodate the desired mix between expandability and size

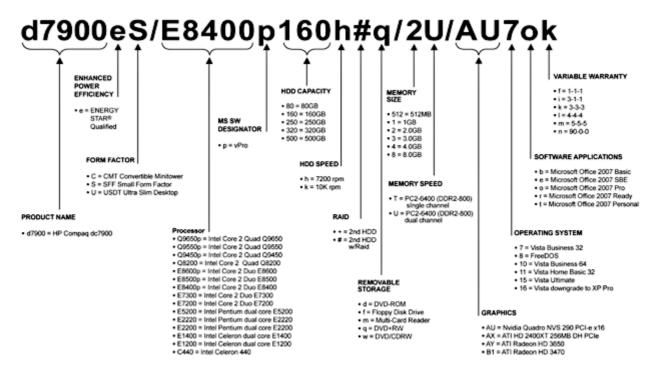


^{*} TPM module and cryptographic software disabled where use is restricted by law; for example, Russia and China.

Configurable Components - Select Models (localized by Regions)

Model Key and Example

NOTE: This diagram is an example that illustrates how to read the model number. It is not intended to give every available configuration choice specified in the body of this document and may include references to modules that are out of date and no longer available.





Standard Features and Configurable Components

Operating System - One of the following

Preinstalled Genuine Windows 7 Professional (64-bit)*

Genuine Windows Vista Business SP1 (32-bit)**
Genuine Windows Vista Home Basic SP1 (32-bit)**
Genuine Windows Vista Ultimate SP1 (32-bit)**

FreeDOS_t

Supported Genuine Windows 7 Enterprise (32-bit)*

Genuine Windows 7 Enterprise (64-bit)*

Genuine Windows Vista Business SP1 (64-bit)**
Genuine Windows Vista Enterprise SP1 (32-bit)**
Genuine Windows Vista Enterprise SP1 (64-bit)**

Certified Novell SUSE Linux Enterprise Desktop[†]

Red Hat Linux[†]

† The following features are not supported on Linux certified systems:

- HP 22-in-1 Media Card Reader
- HP 1.44-MB External USB Diskette Drive
- TPM 1.2 Security Chip
- Intel Pro 1000 PT PCIe x1 Gigabit NIC
- Broadcom NetXtreme Gigabit Ethernet Plus PCIe NIC
- HP 802.11b/g/n Wireless PCIe x1 Card (SFF and MT)
- Intel WiFi Link 5100 a/b/g/n (USDT) Wireless NIC
- Agere PCI 56K International SoftModem
- LSI PCIe x1 56K International SoftModem
- ATI Radeon 3470 256MB SH PCle x16 graphics card
- ATI Radeon HD 2400XT 256MB DH PCIe x16 graphics card
- ATI Radeon HD 3650 512MB DH PCIe x16 graphics card
- NVIDIA Quadro NVS 290 256MB dual head graphics adapter
- HP USB Smartcard Keyboard
- HP 2nd Serial Port
- Parallel port adapter
- eSATA port adapter
- HP FireWire / IEEE 1394 PCI Card



^{*} System may require upgraded and/or separately purchased hardware and/or a DVD drive to install the Windows 7 software and take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

^{**} Certain Windows Vista product features require advanced or additional hardware. See: www.microsoft.com/windowsvista/getready/hardwarereqs.mspx and www.microsoft.com/windowsvista/getready/capable.mspx for details. WindowsVista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: www.windowsvista.com/upgradeadvisor.

Standard Features and Configurable Components

Value-added Software

(included with all models; not included with FreeDOS)

HP ProtectTools Security Suite† **HP Software Management Agent**

HP Backup and Recovery Manager PDF Complete

HP Insight Diagnostics Computrace for Desktops (in the HP BIOS)*

† Not included on models configured with less than 1 GB system memory.

* Computrace agent is in HP BIOS. For tracking and tracing services, available in select countries, separate

software and purchase of a subscription is required.

Value-added Software

(included with select models; not included with FreeDOS)

Computer Setup Utility

McAfee Total Protection Anti-Virus†* Sonic/Roxio Easy Media Creator 9

or

Roxio Business Creator 10

HP Power Manager v2.0 Microsoft Works 8.5 **HP Total Care Advisor†** Firefox-HP Virtual Browser

Microsoft Office 2007 Basic Corel WinDVD 8 † Not included on models configured with less than 1 GB system memory.

* 60 day trial period for McAfee Total Protection for Small Business software. Internet access required to receive updates. First update included. Subscription required for updates thereafter.

HP Client Management Solutions

(available for free download from the Web http://www.hp.com/go/ easydeploy)

HP Client Configuration Manager Basic Edition

HP Client Manager for Altiris

HP SoftPaq Download Manager **HP Client Catalog for Microsoft SMS** **HP Out-of-Band Management Console**

Microsoft Office 2007 Personal

Microsoft Office 2007 Professional

Microsoft Office 2007 Small Business

(for Intel management technology enabled models) Altiris Out-of-Band Management Solution (for Intel

AMT enabled models)

HP Systems Software Manager

Features

Value-added Services and HP Stable Platform Program **Business-to-Business Portals HP Global Series Services** TPM 1.2 security module*

Factory Express Deployment and Lifecycle Services

Intel Standard Manageability

Intel Core 2 processor with vPro Technology

* TPM module disabled where use is restricted by law; for example, Russia.

Standard Features and Configurable Components

Service and Support

On-site Warranty and Service 1 : This three-year (3-3-3), limited warranty and service offering delivers three years of parts, labor and on-site repair. Response time is next business-day 2 and includes free telephone support 3 24 x 7. Global coverage 2 ensures that any product purchased in one country and transferred to another non-restricted country will remain fully covered under the original warranty and service offering. Some countries/regions do not offer one year onsite and labor.

³ Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries.

	Ultra-slim Desktop	Small Form Factor	Convertible Minitower	
Dimensions				
Chassis Dimensions (H x W x D)	2.60 x 9.90 x 10 in (66.0 x 251.5 x 254 mm)	3.95 x 13.3 x 14.9 in (100.3 x 337.8 x 378.5)	17.63 x 7.0 x 17.8 in (447.8 x 177.8 x 452.12 mm)	
Optional Tower Stand Dimensions (H x W x D)	1.26 x 4.82 x 6.69 in (32.0 x122.3 x 170.0 mm)	1.05 x 6.95 x 7.83 in (26.75 x 176.46 x 198.87 mm)	N/A	
System weight*	7.0 lb (3.18 kg)	18.75 lb (8.50 kg)	26.2 lb (11.89 kg)	
System volume	4.21 liters	13 liters	36 liters	
Shipping weight*	14.34 lb (6.52 kg)	26.10 lb (11.86 kg)	34.60 lb (15.72 kg)	
Maximum supported weight (desktop orientation)	77.1 lb (35 kg)	77.1 lb (35 kg)	77.1 lb (35 kg)	
Shipping box dimensions (H x W x D)	8.60 x 15.68 x 19.68 in (218.4 x 398.3 x 499.9 mm)	9.00 x 19.68 x 23.38 in (228.6 x 499.9 x 593.85 mm)	24.25 x 12.33 x 22.13 in (616.0 x 313.2 x 562.1 mm)	
* Configured with 1 hard driv	e, 1 optical drive, no diskette drive,	and no PCI card.		
	Ultra-slim Desktop	Small Form Factor	Convertible Minitower	
Standard Efficiency Power Supply	N/A	240W active PFC	365W active PFC	
Energy Efficient Power Supply	135W active PFC 87% efficient	240W active PFC 85% efficient	365W active PFC 85% efficient	
	External power supply dimensions: 6.7 x 2.6 x 1.5 in Total length of external power supply and power cord: 12 feet 8 inches			
Ports	12.0000			
USB 2.0		(8) Total (2) front, (6) rear		
Serial	N/A	(1) Standard Optional 2 nd port available		
Parallel	N/A	Option		
eSATA	N/A	Option		
PS/2		(1) keyboard; (1) mouse		
Video		(1) VGA; (1) DisplayPort		
DVI output	available via A	ADD2 card or optional DisplayPort to	DVI adapterr	



¹ Terms and conditions may vary by country. Certain restrictions and exclusions apply.

² On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

Standard Features and Configurable Components

Support for Multi-Monitor	Integrated dual independent monitor support standard; > 2 via ADD2 card or optional graphics cards				
Audio		Front – mic and headphone ut (supports microphone or line inpu			
NIC (RJ-45)	Integrated Intel 82567LM GbE Network Connection				
Slots					
Type and quantity	(1) mini PCI Express	(1) PCI (1) PCI Express x1 (2) PCI Express x16	(3) PCI (1) PCI Express x1 (2) PCI Express x16		
Slot specifications		 Accommodates low profile cards only Graphics slots support 35W cards 2nd PCIe x16 slot functions electrically as a x4 	 Accommodates full height cards 1st graphics slot supports 75W card; 2nd graphics slot support 35W card 2nd PCIe x16 slot functions electrically as a x4 		

Chipset	Intel Q45 Express chipset featuring Intel GMA 4500 DirectX 10 graphics	USDT X	SFF X	CMT X
Processor and Speed*	Intel Celeron Dual-Core Processors:			
One of the following	Intel Celeron dual-core E1200 processor 1.6 GHz, 512 KB L2 cache, 800 MHz FSB	X	Х	Х
	Intel Celeron dual-core E1400 processor 2.0 GHz, 512 KB L2 cache, 800 MHz FSB	X	Х	Х
	Intel Pentium dual-core Processors:			
	Intel Pentium dual-core E5200 processor 2.5 GHz, 2 MB L2 cache, 800 MHz FSB	X	Х	Χ
	Intel Core 2 Duo Processors:			
	Intel Core 2 Duo E7200 processor 2.53 GHz, 3 MB L2 cache, 1066 MHz FSB			
	Intel Core 2 Duo E7300 processor 2.66 GHz, 3 MB L2 cache, 1066 MHz FSB	X	X	Х
	Intel Core 2 Duo E8400 processor 3.0 GHz, 6 MB L2 cache, 1333 MHz FSB Featuring Core 2 Processor with vPro Technology	Х	Χ	Х
	Intel Core 2 Duo E8500 processor 3.16 GHz, 6 MB L2 cache, 1333 MHz FSB Featuring Core 2 Processor with vPro Technology	Х	Х	Х
	Intel Core 2 Duo E8600 processor 3.33 GHz, 6 MB L2 cache, 1333 MHz FSB Featuring Core 2 Processor with vPro Technology	Х	Х	Х
	Intel Core 2 Quad Processors:			
	Intel Core 2 Quad Q8200 processor 2.33 GHz, 4 MB L2 cache, 1333 MHz FSB		X	X



Standard Features and Configurable Components

Intel Core 2 Quad Q9400 processor 2.66 GHz, 6 MB L2 cache, 1333 MHz FSB Featuring Core 2 Processor with vPro Technology	X	X
Intel Core 2 Quad Q9550 processor 2.83 GHz, 12 MB L2 cache, 1333 MHz FSB Featuring Core 2 Processor with vPro Technology	Х	X
Intel Core 2 Quad Q9650 processor 3.0 GHz, 12 MB L2 cache, 1333 MHz FSB Featuring Core 2 Processor with vPro Technology	Х	X

Intel Core 2 Processor with vPro Technology

All dc7900 Series models featuring this technology include processors which are part of the Intel 2008 Stable Image Platform Program (SIPP) designed to ensure the stability promise inherent in the value proposition of the HP Compaq dc7900 Series business desktop, thus making these model the most stable, secure, and manageable platforms available to enterprises today.

x x x

The 2008 SIPP processors are:

- Core 2 Duo E8400, E8500, E8600
- Core 2 Quad Q9400, Q9550, Q9650

Intel's Core 2 Processor with vPro Technology suite of features includes:

Intel Active Management Technology

an advanced set of remote management features and functionality which provides network administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. Intel Active Management Technology includes all features described as part of Intel Standard Manageability plus the following advanced management functions:

- Fast Call for Help a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection
- Remote Scheduled Maintenance pre-schedule when the PC connects to the IT or service provider console for maintenance.
 Remote PCs can get required patches, be inventoried, etc by connecting to their IT console or Service Provider when it's convenient
- Remote Alerts automatically alert IT or service provider if issues arise
- Access Monitor Provides oversight into Intel® AMT actions to support security requirements

Microsoft NAP Support

Allows Intel Active Management Technology to gain access to a Microsoft NAP enabled 802.1x network 00B to enable 00B SW updates, inventories, remote diagnostics, etc. NAP is a new platform and solution that controls access to network resources based on a client computer's identity and compliance with corporate governance policy. NAP allows network administrators to define granular levels of network access based on who a client is, the groups to which the client belongs, and the degree to which that



Standard Features and Configurable Components

client is compliant with corporate governance policy. If a client is not compliant, NAP provides a mechanism to automatically bring the client back into compliance and then dynamically increase its level of network access.

When a client attempts to access the network or communicate on the network, it must present its system health state or proof of health compliance. If a client cannot prove it is compliant with system health requirements (for example, that it has the latest operating system and antivirus updates installed), its access to the network or communication on the network can be limited to a restricted network containing server resources so that health compliance issues can be remedied. After the updates are installed, the client requests access to the network or attempts the communication again. If compliant, the client is granted unlimited access to the network or the communication is allowed.

Memory

DDR2 SYNCH DRAM NON-ECC MEMORY

Memory upgrades are accomplished by adding single or multiple DIMMs of the same or varied sizes. This chart does not represent all possible memory configurations. The HP Compaq dc7900 business desktop supports non-ECC DDR2 PC2-5300 (667-MHz) and PC2-6400 (800-MHz) memory.

CAUTION: You must shut down the computer and disconnect the power cord before adding or removing memory modules. Regardless of the power-on state, voltage is always supplied to the memory modules as long as the computer is plugged in to an active AC outlet. Adding or removing memory modules while voltage is present may cause irreparable damage to the memory modules or system board.

HP recommends dual-channel symmetric configurations for maximum performance.

For best performance, add the same amount of total memory to each channel and do not mix speeds. For dual-channel symmetric performance, the total amount of memory in each channel must be equal. If speeds are mixed, speed will default to the slowest DIMM.

RAID

Redundant Array of Independent Drives

Flexible implementation:

- DriveLock is supported while in RAID mode. Users can manage DriveLock password from within F10
 Setup. Locked drives will be displayed as such in the RAID option ROM interface.
- Hard drive information can be viewed within F10 Setup while in RAID mode. Previously, the hard drives will not appear in Drive Configuration when switching to RAID mode.
- DPS Self Test can be executed on physical hard drives while in RAID mode.
- The RAID Setup Utility (accessed through CTRL-I) can be protected by the F10 Setup password.

NOTE: RAID 1 is the only RAID configuration that HP Compaq dc7900 Business PC products offer as factory configurations. The pre-configured systems:

- Are only available on the CMT and SFF form factors. The USDT does not support RAID as it does not allow for more than one hard disk drive.
- Are complete RAID systems and have both drives installed.
- Have the necessary Option ROM configuration.
- Are pre-loaded and pre-installed with all required Intel software.
- Include a preinstalled operating system that is mirrored mode out of the box.



Standard Features and Configurable Components

Please refer to the HP White Paper titled "Advanced Host Controller Interface (AHCI) and Redundant Array of Independent Disks (RAID) on HP Compaq dc7900 Business PCs" at http://www.hp.com for more information and instructions.

Ultra-slim Desktop

Maximum Memory*

Supports up to 8 GB of DDR2 SYNCH DRAM using SO-DIMM modules. Slot 1 is black and must always be populated. Not all memory configurations possible are represented below.

NOTE: For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements.

SO-DIMM Size	SI	ot
	Channel A	Channel B
	1 (black)	2 (white)
512-MB	512-MB	
1-GB	1-GB	
2-GB (dual-channel symmetric)	1-GB	1-GB
4-GB (dual channel symmetric)	2-GB	2-GB
8-GB maximum (dual channel symmetric)	4-GB	4-GB

^{*} The Intel Q45 Express chipset includes a built-in Management Engine (ME), which allocates memory for manageability functions. Management Engine memory is shared with system memory. If the PC contains a single SO-DIMM, 16 MB of memory is pre-allocated for it at system startup. If the PC contains two SO-DIMMs, 32 MB of memory is pre-allocated. This memory is not made available to the operating system, just as pre-allocated video memory is not available.

Small Form Factor and Convertible Minitower

Maximum Memory*

Supports up to 16 GB of DDR2 SYNCH DRAM using DIMM modules. Slot 1 is black and must always be populated. Not all memory configurations possible are represented below.

NOTE: For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.



Standard Features and Configurable Components

DIMM Size		Slot				
	Cha	nnel A	Char	nnel B		
	1 (black)	2 (white)	3 (white)	4 (white)		
512-MB	512-MB					
1-GB	1-GB					
2-GB (dual-channel symmetric)	1-GB		1-GB			
4-GB (dual-channel symmetric)	1-GB	1-GB	1-GB	1-GB		
8-GB (dual-channel symmetric)	2-GB	2-GB	2-GB	2-GB		
16-GB maximum (dual-channel symmetric)	4-GB	4-GB	4-GB	4-GB		

^{*} The Intel Q45 Express chipset includes a built-in Management Engine (ME), which allocates memory for manageability functions. Management Engine memory is shared with system memory. If the PC contains a single DIMM, 16 MB of memory is pre-allocated for it at system startup. If the PC contains two DIMMs, 32 MB of memory is pre-allocated. This memory is not made available to the operating system, just as pre-allocated video memory is not available.

		USDT	SFF	CMT	
Memory Configurations –	512-MB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (1 x 512)	X	Χ	Χ	
One of the following	1-GB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (1 x 1GB)	X	Χ	Χ	
	2-GB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (1 x 2GB)	X	Χ	Χ	
	2-GB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (2 x 1GB)	X	Χ	Χ	
	3-GB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (3 x 1GB)		Χ	Χ	
	4-GB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (4 x 1GB)		Χ	Χ	
	4-GB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (2 x 2GB)	X	Χ	Χ	
	8-GB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (4 x 2GB)		Χ	Χ	
	16-GB DDR2 Synch Dram PC2-6400 (800-Mhz) Non ECC (4 x 4GB)		Χ	Χ	



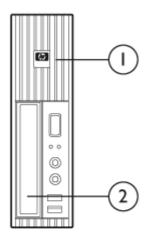
Standard Features and Configurable Components

Expandability	USDT	SFF	СМТ
PCI slots	N/A	(1) LP (2.5"), length (6.6") standard; (2) FH (4.2"), length (6.875") via optional riser card. NOTE: With optional riser card, PCle x1 and PCle x16 slots are not accessible.	(3) FH (4.2"), length (10.5")
Max power per slot	N/A	25W	25W
PCI Express x16 slot (Also functions as SDVO/ADD2 Slot)	N/A	(2) LP (2.5"), length (6.6")	(2) FH (4.2"), full-length
Max power per slot	N/A	35W	75W max if 1 16x slot, 35W each if both PCIe 16 slots
PCI Express x1 slot	N/A	(1) LP (2.5"), length (6.6")	(1) FH (4.2"), full-length
Max power per slot	N/A	10W	10W
External Bays	(1) Total	(2) Total	(4) Total
3.5"	N/A	(1) unless used for a secondary hard drive	(1)
5.25"	N/A	(1) 8.189" length	(2) 8.189" length (1) 5.71" length
Slimline	128w x 127d x 12.7h mm	N/A	N/A
Internal 2.5" HDD Bays	(1)	N/A	N/A
Internal 3.5" HDD Bays	N/A	(1) for primary hard drive NOTE: Secondary hard drive can be installed in 3.5" external bay if not used for external device.	(2) dedicated for HDDs NOTE: A third hard drive can be installed in 3.5" external bay if not used for external device.
Hard Drive Controller (PCI) Supported	suppo	Serial ATA ort for SATA 1.5-Gb/s and 3.0-Gb/s hard	d drives
Hard Drive and Optical SATA Interfaces Supported	(1) Serial ATA interface	(3) Serial ATA interfaces (1) Serial ATA for eSATA	(4) Serial ATA interfaces (1) Serial ATA for eSATA
Host Controller for SATA		face (AHCI) Revision 1.2. The specificated face between system software and the	•

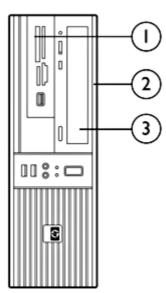


Standard Features and Configurable Components

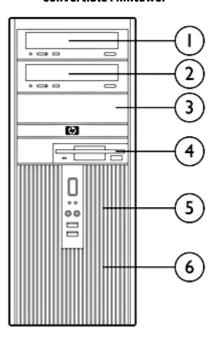
Ultra-slim Desktop



Small Form Factor



Convertible Minitower



Storage - Drive Support

	U:	SDT	SFF				CMT	
	Slimline Optical Drives	2.5" Hard Disk Drive or Solid State Drive (right angle, no cable)	Diskette Drive or Media Card Reader	5.25" Optical Drives	Hard Disk Drives	Diskette Drive or Media Card Reader*	5.25" Optical Drives	Hard Disk Drives
Quantity Supported	1	1	1	1	2	1	2	3
Position Supported	2	1	1	2	1,3	4	1,2	2 _{1,} (5),
Controller	SATA	SATA	Diskette Controller or USB header on PCA	SATA	SATA	Diskette Controller or USB header on PCA	SATA	SATA

^{*} To have both a diskette drive and a media card reader in the Convertible Minitower, it is necessary to order it with a diskette drive in position 4 and then purchase a media card reader as an after-market option kit (which contains a 5.25" bracket) and install it in position 3



[†] Installing a 3.5-inch hard drive in position #2 (a 5.25-inch optical drive bay) requires the optional HP Optical Bay HDD Mounting Bracket.

Standard Features and Configurable Components

		USDT	SFF	CMT
	30 GB Hard Drive (2.5")	Χ		
8	BMB cache, 7200 RPM, 3.0 GB/s, NCQ, Smart IV			
	250 GB Hard Drive (2.5")	Χ		
ð	BMB cache, 7200 RPM, 3.0 GB/s, NCQ, Smart IV			
_	30 GB Hard Drive		Χ	Х
	BMB cache, 7,200 RPM, 3.0 GB/s, NCQ, Smart IV			
_	30 GB Hard Drive I 6MB cache, 10,000 RPM, 3.0 GB/s, NCQ, Smart III		Χ	Х
	30 GB Hard Drive (removable)		Х	Χ
	BMB cache, 7,200 RPM, 3.0 GB/s, NCQ, Smart IV			
2	250 GB Hard Drive		Χ	Х
8	BMB cache, 7,200 RPM, 3.0 GB/s, NCQ, Smart IV			
_	250 GB Hard Drive (removable)		Χ	Χ
8	BMB cache, 7,200 RPM, 3.0 GB/s, NCQ, Smart IV			
5	500 GB Hard Drive		Χ	Х
1	16MB cache, 7,200 RPM, 3.0 GB/s, NCQ, Smart IV			
Removable Storage – D	Diskette Drives			
	1.44-MB Diskette Drive		Χ	Χ
following depending on form factor (see Storage –	5.25" Optical Drives (SATA)			
	DVD-ROM Drive		Χ	Χ
	SuperMulti LightScribe DVD Writer Drive ^{1,2,3}		Χ	Χ
S	Slimline Optical Drives (SATA)			
	DVD-ROM Drive ¹	Χ		
S	SuperMulti LightScribe DVD Writer Drive ^{1,2,3}	Χ		
	For playing DVDs, Corel WinDVD 8			
	For writing CDs, choice of Sonic/Roxio Easy Media Creator 9 or Roxio Business Creator 10			
	For writing CDs and DVDs, video editing and authoring DVDs, choice of Sonic/Roxio			
	Easy Media Creator 9			
	or Roxio Business Creator 10			
	HP 22-in-1 Media Card Reader		Х	X
Media Card Reader - One H	II ZZ III I Picula cara Reader		, ,	/\



Standard Feature	s and Configurable Components			_
Security	TPM 1.2 TPM Security Chip*	Х	Х	Х
	TPM Pre-Boot Authentication (via BIOS)	Χ	Χ	Χ
	Smartcard Pre-boot Authentication (via BIOS)	Χ	Χ	Χ
	Stringent Security** (via BIOS)	Χ	Χ	Χ
	SATA port disablement (via BIOS)	Χ	Χ	Χ
	Drive Lock	Χ	Χ	Χ
	RAID configurations		Χ	Χ
	HP ProtectTools Embedded Security Software	Χ	Χ	Χ
	Serial, Parallel, USB Enable/Disable (via BIOS)	Χ	Χ	Χ
	Removable Media Write/Boot Control	Χ	Χ	Χ
	Power-On Password (via BIOS)	Χ	Χ	Χ
	Setup Password (via BIOS)	Χ	Χ	Χ
	Solenoid Hood Lock / Sensor***	Χ	Χ	Χ
	HP Security Lock Kit***	Χ	Χ	Χ
	* TPM module disabled where use is restricted by law; for example, Russia. ** This setting is defaulted to disable, but when enabled, the PW jumper will not clear the BIOS pre-boot authentication passwords. *** The Solenoid Hood Lock / Sensor and HP Security Lock Kit are optional features.			
NIC	Intel 82567LM GbE Network Connection (integrated on system board)	х	Х	Х
	Intel Gigabit CT Desktop NIC*		Χ	Χ
	Broadcom NetXtreme Gigab Ethernet + NIC AV FS601AV			
	NOTE: The integrated network connection is required to support the vPro technology features. * Available after initial product release; use of this network card disables the vPro technology features.			
Wireless	HP 802.11 b/g/n PCIe x1 Wireless card		Х	Χ
	Intel WiFi Link 5100 a/b/g/n (USDT) Wireless NIC	Χ		
	NOTE: These wireless network solutions disable the vPro technology features.			
Modem	Agere 2006 PCI 56K International SoftModem		Х	
	LSI PCIe x1 Hi-Speed 56K International SoftModem		Х	Χ



Standard Featur	es and Configurable Components			
Graphics	Intel Graphics Media Accelerator 4500 (integrated on chipset)	Χ	X	Х
	ATI Radeon 3470 256MB SH PCIe x16 graphics card		X	Х
	ATI Radeon HD 2400XT 256MB DH PCIe x16 graphics card		Χ	X
	ATI Radeon HD 3650 512MB DH PCIe x16 graphics card		v	X
	ATI Radeon HD 4550 Dual Head PCIe x16 Graphics Card		X	X
	NVIDIA Quadro NVS 290 256MB DH PCIe x16 graphics card		X	X
	NVIDIA Quadro NVS 295 256MB Graphics Card		X	Х
	HP ADD2 SDVO PCIe DVI-D adapter		Χ	Χ
	HP DisplayPort to VGA Adapter	X	X	X
Audio	Integrated HD audio with AD1884A codec (all ports are stereo)	Х	Χ	Х
	Microphone and Headphone front ports	Χ	Χ	Χ
	Line-out and Line-In rear ports*	Χ	Χ	Χ
	Multistreaming capable*	Χ	Χ	Χ
	Internal Speaker (standard)	Χ	Χ	Χ
	HP Thin USB Powered Speakers	Χ	Χ	Χ
	* Rear audio input ports are re-taskable as Line-in or Microphone-in. External speakers must be powered externally. Multistreaming can be enabled in the ADI control panel to allow independent audio streams to be sent to/from the front and rear jacks. This allows for different audio applications to use separate audio ports on the system. For example, the front jacks could be used with a headset for a communications application while the rear jacks are being used with external speakers and a multimedia application.			
Input Devices	Keyboard			
	HP PS/2 Standard Keyboard	Χ	Χ	Χ
	HP USB Standard Keyboard	Χ	Χ	Χ
	HP USB Smartcard Keyboard	Χ	Χ	Χ
	Mouse - One of the following			
	HP PS/2 2-button Optical Scroll Mouse	Χ	Χ	Χ
	HP USB 2-button Optical Scroll Mouse	Χ	Χ	Χ
	HP USB 2-Button Laser Scroll Mouse	Χ	Χ	Χ



Χ

QuickSpecs

Standard Features and Configurable Components HP FireWire (IEEE 1394) PCI Card Miscellaneous Χ Χ PCI riser card for SFF - adds 2 full-height PCI slots Χ **NOTE:** Low profile slots are unusable with riser card installed. Serial port adapter Χ Χ Parallel port adapter Χ Χ Χ Χ eSATA port adapter Tower stand Χ Χ Configure dc7900 CMT in desktop orientation Χ

Rear Port Control Cover



After-Market Options (availability may vary by region)

		USDT	SFF	CMT	After-Market Options Part Number
Office 2007 Media-less	MS Office Basic Edition 2007 – Media-less License Kit	Х	Χ	Χ	RZ361A#ABA
License Kits (MLKs)	MS Office Small Business Edition 2007 – Media-less License Kit	Χ	Χ	X	RZ365A#ABA
	MS Office Professional Edition 2007 – Media-less License Kit	Х	Х	Х	RZ363A#ABA
Communications	Wireless				
	HP Wireless 802.11 b/g/n PCIe x1		Χ	X	FH971AA
	NICs				
	Broadcom NetXtreme Gigabit Ethernet Plus PCIe NIC		Χ	X	FS215AA
	Intel Gigabit CT Desktop NIC		Χ	X	FH969A
	Modem				
	LSI PCIe x1 Hi-Speed 56K International SoftModem		Χ	Χ	FH970A
	Connectivity				
	Bundle Connectivity Starter Kit – Surge Protector/LAN cable/Printer cable		X	Χ	RT174AA
	* available after initial product release NOTE: The use of a PCI Express network card (wired or wireless) technology features.	will disal	ole the	vPro	
Graphics	Single head solutions				
Graphics	Single head solutions ATI Radeon 3470 256MB SH PCIe x16		Х	Х	FH972A <i>F</i>
Graphics	-		х	X	FH972A <i>f</i>
Graphics	ATI Radeon 3470 256MB SH PCIe x16		x x	X X	
Graphics	ATI Radeon 3470 256MB SH PCIe x16 Multi head solutions NVIDIA Quadro NVS 290 Dual Head PCIe x16, low profile Graphics				KG748AA
Graphics	ATI Radeon 3470 256MB SH PCIe x16 Multi head solutions NVIDIA Quadro NVS 290 Dual Head PCIe x16, low profile Graphics Card		X	х	KG748AA KD060AA
Graphics	ATI Radeon 3470 256MB SH PCIe x16 Multi head solutions NVIDIA Quadro NVS 290 Dual Head PCIe x16, low profile Graphics Card ATI Radeon HD 2400XT 256MB DH PCIe x16		X	x x	KG748AA KD060AA KS505AA
	ATI Radeon 3470 256MB SH PCIe x16 Multi head solutions NVIDIA Quadro NVS 290 Dual Head PCIe x16, low profile Graphics Card ATI Radeon HD 2400XT 256MB DH PCIe x16 ATI Radeon HD 3650 512MB DH PCIe x16		x x	x x x	KG748AA KD060AA KS505AA
	ATI Radeon 3470 256MB SH PCIe x16 Multi head solutions NVIDIA Quadro NVS 290 Dual Head PCIe x16, low profile Graphics Card ATI Radeon HD 2400XT 256MB DH PCIe x16 ATI Radeon HD 3650 512MB DH PCIe x16 ATI HD 4550 PCIe x16 (256GB/DDR3) Dual Head Graphics Card		x x	x x x	KG748AA KD060AA KS505AA AT042AA
	ATI Radeon 3470 256MB SH PCIe x16 Multi head solutions NVIDIA Quadro NVS 290 Dual Head PCIe x16, low profile Graphics Card ATI Radeon HD 2400XT 256MB DH PCIe x16 ATI Radeon HD 3650 512MB DH PCIe x16 ATI HD 4550 PCIe x16 (256GB/DDR3) Dual Head Graphics Card Serial ATA Hard Drives		x x x	X X X X	KG748AA KD060AA KS505AA AT042AA
	ATI Radeon 3470 256MB SH PCIe x16 Multi head solutions NVIDIA Quadro NVS 290 Dual Head PCIe x16, low profile Graphics Card ATI Radeon HD 2400XT 256MB DH PCIe x16 ATI Radeon HD 3650 512MB DH PCIe x16 ATI HD 4550 PCIe x16 (256GB/DDR3) Dual Head Graphics Card Serial ATA Hard Drives HP 80-GB SATA (NCQ/Smart IV) 3.0-Gb/s HDD		x x x	x x x x	KG748AA KD060AA KS505AA AT042AA PY276AA PY278AA
	ATI Radeon 3470 256MB SH PCIe x16 Multi head solutions NVIDIA Quadro NVS 290 Dual Head PCIe x16, low profile Graphics Card ATI Radeon HD 2400XT 256MB DH PCIe x16 ATI Radeon HD 3650 512MB DH PCIe x16 ATI HD 4550 PCIe x16 (256GB/DDR3) Dual Head Graphics Card Serial ATA Hard Drives HP 80-GB SATA (NCQ/Smart IV) 3.0-Gb/s HDD HP 250-GB SATA (NCQ/Smart IV) 3.0-Gb/s HDD		x x x	X X X X	KG748AA KD060AA KS505AA AT042AA PY276AA PY278AA KW347AA
	ATI Radeon 3470 256MB SH PCIe x16 Multi head solutions NVIDIA Quadro NVS 290 Dual Head PCIe x16, low profile Graphics Card ATI Radeon HD 2400XT 256MB DH PCIe x16 ATI Radeon HD 3650 512MB DH PCIe x16 ATI HD 4550 PCIe x16 (256GB/DDR3) Dual Head Graphics Card Serial ATA Hard Drives HP 80-GB SATA (NCQ/Smart IV) 3.0-Gb/s HDD HP 250-GB SATA (NCQ/Smart IV) 3.0-Gb/s HDD HP 500-GB SATA (NCQ/Smart IV) 3.0-GB/s HDD		x x x	X X X X	KG748AA KD060AA KS505AA AT042AA PY276AA PY278AA KW347AA FH966AA
Graphics Hard Disk Drives	ATI Radeon 3470 256MB SH PCIe x16 Multi head solutions NVIDIA Quadro NVS 290 Dual Head PCIe x16, low profile Graphics Card ATI Radeon HD 2400XT 256MB DH PCIe x16 ATI Radeon HD 3650 512MB DH PCIe x16 ATI HD 4550 PCIe x16 (256GB/DDR3) Dual Head Graphics Card Serial ATA Hard Drives HP 80-GB SATA (NCQ/Smart IV) 3.0-Gb/s HDD HP 250-GB SATA (NCQ/Smart IV) 3.0-Gb/s HDD HP 500-GB SATA (NCQ/Smart IV) 3.0-GB/s HDD HP 65ATA Adapter		x	x x x x	FH972AA KG748AA KD060AA KS505AA AT042AA PY276AA PY278AA KW347AA FH966AA RY102AA



After-Market Optior	ns (availability may vary by region)				
Input/Output Devices	Wirelss Keyboard and Mouse				
	2.4 GHz Wireless Keyboard and Mouse	Х	Х	Χ	NB896AA
	Keyboards				
	HP PS/2 Standard Keyboard	Χ	Χ	Χ	DT527A
	HP USB Standard Keyboard	Χ	Χ	Χ	DT528A
	HP USB Mini Keyboard	Х	Χ	Χ	AS601AA
	HP USB PS2 Washable Keyboard	X	Χ	Χ	VF097AA#ABA
					(launching July 27th)
	Pointing Devices				27111)
	HP Business Mouse Pad				AT485AA
	HP PS/2 2-Button Optical Scroll Mouse	Х	Х	Х	EY703AA
	HP USB 2-Button Optical Scroll Mouse	X	Х	Х	DC172B
	HP USB 2-Button Laser Mouse	X	Х	X	GW405AA
	DC2 6400 (DDB2 900 MH-) DIMM				
Memory (non-ECC)	PC2-6400 (DDR2, 800 MHz) DIMM Promo - 2GB (2 x 1GB) PC2-6400 DDR2-800		Х	Х	NQ604AT
	Promo - 4GB (2 x 2GB) PC2-6400 DDR2-800		X	X	NQ604AT
	HP 1 GB PC2-6400 (DDR2 800 MHz) DIMM		X	X	AH058AA
	HP 2 GB PC2-6400 (DDR2 800 MHz) DIMM		X	X	AH060AA
	HP 4 GB PC2-6400 (DDR2 800) DIMM		X	X	FH977AA
	PC2-6400 (DDR2, 800 MHz) SODIMM		٨	٨	FIISTTAA
	HP 1 GB PC2-6400 (DDR2 800 MHz) SODIMM	Х			GM254AA
	HP 2 GB PC2-6400 (DDR2 800 MHz) SODIMM	X			GV576AA
	HP 4 GB PC2-6400 (DDR2 800 MHz) SODIMM	X			FH978AA
Monitors	CRTs				3PO Offering
11011110113	Value Series Monitors				31 0 onening
	HP LV156w 15-inch Widescreen LCD Monitor				NJ711AA#ABA
	Business LCD Monitors				וואוווא
	HP L1506 15-inch LCD Monitor				PX848AA#ABA
	HP w17e 17-inch LCD Monitor				GV537AA#ABA
	HP L1710 17-inch LCD Monitor				GS917AA#ABA
	HP L1910 19-inch LCD Monitor				GS918AA#ABA
	HP L1910i 19-inch LCD Monitor with Integrated Work Stand	1			GS581AA#ABA
	HP L1908w 19-inch Widescreen LCD Monitor	•			GP536AA#ABA
	HP L1908wm 19-inch Widescreen LCD Monitor with multimedia				KA214AA#ABA
	HP L1908wii 19-inch Widescreen LCD Monitor with Integrated Work Stand				GP537AA#ABA
	HP L2208w 22-inch Widescreen LCD Monitor	ca from Stanta			GX007AA#ABA
	Advantage Series Monitors				C.COTTIMITION



After-Market Options (availability may vary by region)

	Wired Premium Headset (VoIP and Overture Conf)	Х	X	X	AQ704AA
Multimedia	HP Thin USB Powered Speakers	Х	Х	Х	KK912AA
	Digital Signage Stand				NK353AA
	Digital Signage Speaker				NK352AA
	3M 19-in Privacy Screen Filter				KZ310AA
	3M 17-in Privacy Screen Filter				KM218AA
	HP LCD Hood Kit				KZ301AA
	HP DreamColor Advanced Profiling Solution (aka Puck)				KZ300AA
	HP Integrated Work Stand (stand alone)				GN783AA
	HP Quick Release Kit				EM870AA
	HP Flat Panel Speaker Bar				EE418AA
	HP USB 2.0MP Business WebCam				NX252AA
	Options				
	HP L5006tm 15-inch Touch Screen LCD Monitor				RB146AA#ABA
	Touchscreen Monitor				
	HP LD4200 42-inch LCD Monitor				NH322AA#ABA
	Digital Signage				
	HP LP3065 30-inch Widescreen LCD Monitor				EZ320A4#ABA
	HP LP2480zx 24-inch DreamColor Widescreen LCD Monitor				GV546A4#ABA
	HP LP2475w 24-inch Widescreen LCD Monitor				KD911A4#ABA
	HP LP2275 22-inch Widescreen LCD Monitor Bulk Pack (6 basel	less units)			KD289A6#ABA
	HP LP2275 22-inch Widescreen LCD Monitor				KE289A4#ABA
	HP LP2065 20-inch LCD Monitor				EF227A4#ABA
	HP LP1965 19-inch LCD Monitor				RA373AA#ABA
	Performance Series Monitors				
	HP L2445w 24-inch Widescreen LCD Monitor				KT931AA#ABA
	HP L2245wg 22-inch Widescreen LCD Monitor				FL472AA#ABA
	HP L2045w 20-inch Widescreen LCD Monitor				RD125AA#ABA
	HP L1945w 19-inch Widescreen LCD Monitor				KD286AA#ABA
	HP L1950g TAA 19-inch LCD Monitor - TAA Compliant				KR145A2#ABA
	HP L1950g 19-inch LCD Monitor				KR145AA#ABA
	HP L1750 17-inch LCD Monitor - TAA Compliant				GF904A2#ABA
	HP L1750 17-inch LCD Monitor				GF904AA#ABA
	HP L1745 17-inch LCD Monitor				GE178AA#ABA



After-Market Option	s (availability may vary by region)				
Slimline Optical Drives	DVD-ROM Drive				
	HP Slim 8X SATA DVD-ROM Drive	Х			FH967AA
	Combo Drive				
	HP Slim 24X SATA CD-RW/DVD-ROM Combo Drive	Х			KV842AA
	DVD Writer				
	HP Slim 8X SATA SuperMulti LightScribe Drive	Х			KV843AA
Standard Optical Drives	DVD-ROM Drive				
	HP SATA DVD-ROM Drive		Χ	Χ	AH047AA
	DVD Writer				
	HP SATA SuperMulti LightScribe DVD Writer Drive		Χ	Χ	GF343AA
	Blu-ray				
	HP 16X SATA Blu-ray Writer		X	Χ	AR481AA
Removable Storage	Diskette and Digital Drives				
	HP 1.44-MB External USB Diskette Drive	Х	Χ	Χ	DC141B
	HP 1.44-MB Standard Internal Diskette Drive		Χ	Χ	AH053AA
	Multimedia				
	HP 22-in-1 Media Card Reader with FireWire (IEEE 1394)		Х	Х	KN518AA
Security	Kensington Lock	Х	Х	Х	PC766A
	HP Business PC Security Lock	Х	Χ	Χ	PV606AA
	HP Chassis Security Kit		Χ	Χ	AR639AA
	HP Rear Port Controller Cover (USDT)	Χ			GJ121AA
	HP (SFF) Solenoid Lock/Hood Sensor		Χ		GJ116AA
	HP (CMT) Solenoid Lock/Hood Sensor			Χ	DE618A
	HP 2008 Wall Mount/Security Sleeve (SFF)		Χ		GF344AA
	HP ProtectTools Version 4.0 (1 User)	Χ	Χ	Χ	FH974AA
	HP USB Smartcard Keyboard	Х	Χ	Χ	ED707AA



After-Market Option	ons (availability may vary by region)				
Software	HP Client Configuration Manager, Premium Edition	X	X	Х	T3488AA (use T3489AA for 1000 licenses)
	Altiris Client Management Suite Level 1 Includes: Altiris Deployment Solution Altiris Inventory Solution Altiris Application Metering Solution Altiris Carbon Copy Solution Altiris Software Delivery Solution Altiris Application Management Solution Altiris Patch Management Solution	X	X	X	DR605A (use DR606A for 1000+ licenses)
Brackets/Stands/	HP Compaq Integrated Work Centre Stand	х			GN783AA
Mounting	HP L1908wi Wide LCD Monitor (L1908wi includes integrated work centre stand)	Х			GP536AA#ABA
	HP L1910i LCD Monitor (L1910i includes integrated work centre stand)	Χ			GS571AA#ABA
	HP Quick Release Mount (mount to wall, under a desk ect)	Χ			EM870AA
	HP Tower Stand for USDT	Χ			GJ117AA
	HP Tower Stand for SFF		Х		GJ118AA
Miscellaneous	HP USB Graphics Adapter	Х	Х	Х	NL571AA
Accessories	DisplayPort TO VGA Adapter	Χ	Χ	Χ	AS615AA
	DisplayPort TO DVI-D Dual Link Adapter (WKS offering)	Х	Х	Х	NR078AA (launching July 6th)
	DMS-59 to Dual VGA Cable Kit	Х	Х	Х	GS567AA
	HP DMS59 DVI Dual-head Connector Cable		Х	Х	DL139A
	HP DVI to DVI Cable		Х	Χ	DC198A
	HP DisplayPort To DVI-D Adapter	Χ	Х	Χ	FH973AA
	HP Serial Port adapter kit		Х	Χ	PA716A
	HP Parallel Port Adapter		Х	Х	KD061AA
	Belkin USB to Serial Adapter	Χ	Х	Х	EM449AA
	SFF PCI Riser Card		Х		AR954AA
	HP 5.25" Blank Bezel Kit (50 pack)		Х	Х	DC177B
	HP FireWire (IEEE 1394) PCI Card		Х	Х	PA997A
	Cat5e Patch Cable	Χ	Х	Х	AH122AA
	Firewire (1394) Cable	Х	Х	Х	AH123AA
	7-outlet Surge Protector	Х	Х	Х	AG290AA#ABA
	HP 1TB Media Vault Pro MV5140	Х	Х	Х	GX667AA#ABA
	HP 1.5 TB Media Vault Pro MV 5150	Х	Х	Х	GX668AA#ABA



Technical Specifications

Conditions	ent and Operating Ultra-slim Desktop Small Form Factor Convertible Minitower
Colluitions	

General Unit Operating Guidelines

- Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is operated within the specified operating range.
- Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's recirculated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign matter can block the vents and limit the airflow.
- If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply.

Temperature Range	Operating: 50° to 95° F (10° to 35° C)*	
	Non-operating: –22° to 140° F(–30° to 60° C)	
Relative Humidity	Operating: 10% to 90% (non-condensing at ambient)	
·	Non-operating: 5% to 95% (non-condensing at ambient)	
Maximum Altitude	Operating: 10,000 ft (3048 m)	
(unpressurized)	Non-operating: 30,000 ft (9144 m)	
•	·	

* Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.

Power Supply	Ultra-slim Desktop	Small Form Factor	Convertible Minitower
Standard Efficiency	N/A	240W standard efficiency active PFC	365W standard efficiency active PFC
Energy Efficient	135W 87% efficient active PFC (external)	240W 85% efficient active PFC	365W 85% efficient active PFC
Operating Voltage Range	90 – 264 VAC	90 – 264 VAC	90 – 264 VAC
Rated Voltage Range	100 – 240 VAC	100 – 240 VAC	100 – 240 VAC
Rated Line Frequency	50/60 Hz	50/60 Hz	50/60 Hz
Operating Line Frequency Range	47 – 63 Hz	47 – 63 Hz	47 – 63 Hz
Rated Input Current	N/A	4A	6A
Rated Input Current with Energy Efficient* Power Supply	1.5A	3.5A	5A
Current Leakage (NFPA 99)	< 275 μΑ	< 275 μΑ	< 450 μA
System Heat Dissipation	N/A	Typical 198 btu/hr (50 kg-cal/hr) Maximum 1260 btu/hr (318 kg-cal/hr	Typical 222 btu/hr (56 kg-cal/hr) Maximum 1916 btu/hr (483 kg-cal/hr)
System Heat Dissipation with Energy Efficient* Power Supply	Typical 133 btu/hr (33.5 kg-cal/hr) Maximum 549 btu/hr (132 kg-cal/hr)	Typical 150 btu/hr (38 kg-cal/hr) Maximum 1024 btu/hr (258 kg-cal/hr)	Typical 171 btu/hr (43 kg-cal/hr) Maximum 1557 btu/hr (392 kg-cal/hr)
	Ultra-slim Desktop	Small Form Factor	Convertible Minitower



Technical Specifications

Power Supply Fan	N/A	80mm variable speed	92mm variable speed
FEMP Standby Power Compliant	X	X	X
(<2W in S5 – Power Off)*			
Power Consumption in ES Mode –	< 2.7W	< 2.7W	< 2.7W
Suspend to RAM (S3) (Instantly			
Available PC)			

^{*} Energy efficient power supply is a requirement for ENERGY STAR qualification in conjunction with a select range of processors and modules; ENERGY STAR models branded HP Compag dc7900e

ROM BIOS Information

Key features of the HP BIOS in the dc7900 include:

- Deployment and manageability HP BIOS provides several technologies that help integrate the HP Business desktop computer into the enterprise, such as PXE, remote configuration, remote control, and F10 Setup support for 12 languages.
- Select models feature either Intel Standard Manageability or Core 2 processor with vPro Technology.
- Stability HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- Security HP BIOS Configuration for ProtectTools offers a robust and flexible set of security features to help the system administrator secure their systems from removal of sensitive data, and help prevent access by unauthorized users.
- Computrace agent For tracking and tracing services, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies so
 component temperatures are managed for high reliability and to assist in operating the HP Business Desktop computer in any
 enterprise environment.
- Acoustic performance Industry leading acoustic emissions across the range of operating conditions.
- Serviceability HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to upgrade HP Business Desktop computers, including BIOS updates
 from within DOS (Flashbin), BIOS updates from within Windows (HPQFlash, SSM), HP Client Manager, and fail-safe recovery. In
 addition, the HP Business Desktop BIOS Utilities tool enables replicated BIOS setup throughout the Enterprise; it is available
 from within the BIOS software and from the support website.

Additional HP BIOS Features

- Power-On password Helps prevent an unauthorized user from powering on the system. After a TPM Basic User password is established in windows, the user or admin can require TPM hardware based authentication during the power-on process.
- Administrator password Also known as the setup password, this helps prevent unauthorized changes to the system
 configuration. If the administrator password is not known, the BIOS version cannot be changed and changes cannot be made to
 BIOS settings using F10 setup or under the OS.
- Advanced Configuration and Power Interface (ACPI) Represents a significant innovation in power and configuration
 management, allowing operating systems and applications to manage power based on activity and usage. HP Compaq dc7900
 models use ACPI to provide power conservation features.



Technical Specifications

Other Features	Description
ACPI-Ready Hardware	Advanced Configuration and Power Management Interface (ACPI).
	 Allows the system to wake from a low power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
SMBIOS Ver. 2.5	System Management BIOS, for system management information
Wired for Management Support	Intel-driven, industry-wide initiative to make Intel architecture-based PCs, servers and mobile computers more inherently manageable right out of the box and over the network
Dual-State Power Button	Power button acts as both an on/off button and suspend-to-sleep button

Serviceability Features of System						
Dual Color Power LED on Front of Computer (Indicates Normal Operations and Fault Conditions)						
Diagnostic LED Explanation Table	Number of 1-second red LED blinks followed by 2-second pause, then repeats: 2-processor thermal protection activated 3-processor not installed 4-power supply failure 5-memory error 6-video error 7-PCA failure (ROM detected failure prior to video) 8-invalid ROM, bootblock recover mode					
System/Emergency ROM	Flash ROM	CMOS Battery Holder for easy Replacement				
 Flash Recovery with Video Configuration Record SW 	5 Aux Power LED on System PCA	 Processor ZIF Socket for easy Upgrade 				
 Over-Temp Warning on Screen (Requires IM Agents) 	Clear Password Jumper	DIMM Connectors for easy Upgrade				
HP Backup and Recovery Manager	Clear CMOS Button	 NIC LEDs (integrated) (Green & Amber) 				

Serviceability Features of Chassis							
 Dual Color Power and HD LED - To Indicate Normal Operations and Fault Conditions 	Color coordinated cables and connectors	Tool-less Hood Removal					
Front power switch	 System memory can be upgraded without removing the system board or any internal components 	 Tool-less Hard Drive, CD & Diskette Removal 					
 Green Pull Tabs, and Quick Release Latches for easy Identification 							
NOTE: Thumb screw release mechanism is us	sed with the Ultra-slim Desktop chassis cover.						

Additional Features	Description
Intel Standard Manageability	Select models feature Intel's Standard Manageability technology including the following:
	DASH 1.0 DASH compliance for support of industry standards. Support for profile updates.



Technical Specifications

	Host VPN*		
	Support for local management VPN tunneling		
-	y Select models feature Intel's Core 2 Processor with vPro Technology including the following:		
NOTE: Requires the utilization of the			
integrated network connection.	Intel Advanced Management Technology (AMT) 5.0		
	 All Intel Standard Manageability technologies Fast call for help – client outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection Audit Logs – policy based log of AMT actions to deter rogue administrator actions Microsoft NAP Support – allows AMT to gain access to a Microsoft NAP enabled 802.1x network OOB to enable OOB SW updates, inventories, remote diagnostics, etc. 		
DASH 1.0 support (Desktop and Mobile Architecture for System Hardware)	A standards initiative for representing out-of-band management capability for computer systems. It is a secure, web-services based successor to ASF.		
ASF 2.0 support (Alert Standard Format)	Industry-standard specification for network alerting in operating system-absent environments		
TXT (Trusted Execution Technology) and VT-d (Virtualized devices)	 TXT allows for secure management (via TPM) and measured launch of VMM, as well as teardown of secrets in unexpected reset case. TXT support provided in select Intel processors. VT-d is a chipset technology that virtualizes directed I/O Together, TXT and VT-d may be used to support verified launch of a known trusted VMM		
	that also may protect VMs from accessing each other's memory.		
Computrace	Computrace agent support standard		
Tower	Product can be oriented as a tower (in addition to desktop orientation)		
Drive Lock	Implementation of the industry standard ATA Security feature set. When enabled, it prevents software access to user data on the drive until one or two user-defined passwords are provided.		
Drive Self Tests (DPS)*	 Drive Protection System A diagnostic hard drive self test. It scans critical physical components and every sector of the hard drive for physical faults and then reports any faults to the user. Running independently of the operating system, it can be accessed through a Windows-based diagnostics utility or through the computer's setup procedure. It 		
DPS Access through F10 Setup during Boot	 produces an evaluation on whether the hard drive is the source of the problem and needs to be replaced. The system expands on the Self-Monitoring, Analysis, and Reporting Technology (SMART), a continuously running systems diagnostic that alerts the user to certain types of failures. 		
SMART Technology* (Self-Monitoring, Analysis and Reporting Technology)	Allows hard drives to monitor their own health and to raise flags if imminent failures were predicted		
SMART I – Drive Failure Prediction	Predicts failures before they occur. Tracks fault prediction and failure indication parameters such as re-allocated sector count, spin retry count, calibration retry		
SMART II – Off-Line Data Collection	 count By avoiding actual hard drive failures, SMART hard drives act as "insurance" against 		



Technical Specifications

SMART III – Off-Line Read Scanning with Defect Reallocation

SMART IV – End-to-End CRC for hard drives

unplanned user downtime and potential data loss from hard drive failure

- IOEDC: I/O Error Detection Circuitry
- Detects errors in Read/Write buffers on HDD cache RAM
- Interface in F10 setup for all dc7900 platforms provides confirmation of SMART IV support.

* This feature is inoperable when a RAID (Redundant Array of Independent Disks) configuration is enabled.



Technical Specifications - Audio

High Definition Audio Integrated **Type**

High Definition Stereo

Codec

Yes - ADI 4-channel ADI 1884 codec

Audio Jacks Front microphone-In (150-K ohm Input Impedance)

Rear Line-In/Microphone input (150-K ohm Input Impedance, function is

configurable by audio driver)

Rear Line-Out * (190 ohms Output Impedance, expects at least a 10-K ohm

load)

Front Headphone-Out (0.5 Ohm Output Impedance, expects at least a 32 ohm

* Internal Speaker Amplifier is for Internal Speaker only. External Speakers need to be powered externally. Rear Line in audio port is re-taskable as Line-in or Microphone-in.

Multistreaming Capable Multistreaming can be enabled in the ADI control panel to allow independent

audio streams to be sent to/from the front and rear jacks.

8 kHz - 192 kHz Sampling

Wavetable Syntheses

(software)

Yes - Uses OS soft wavetable

Analog Audio Yes

Number of Channels on

Line-Out (mono/stereo) Stereo (Left & Right channels)

Internal Audio Speaker

Power Rating

Internal Speaker Yes **External Speaker Jack** Yes

(Line-Out)

1.5 W

HP Thin USB Powered Speakers

On/Off/Volume Controls Right side of right speaker

Power LED Front of right speaker (green)

FO to 20kHz Frequency response

Watts 2/3 watt (normal/maximum)

Speakers: 5.72 x 3.74 x 0.96 in (14.52 x 9.50 x 2.45 cm) per speaker **Dimensions** $(H \times W \times D)$

Net weight 0.68 lbs (0.31kg)

Environmental Temperature (operating) 14° to 104° F (-10° to 40° C)

(all conditions **Relative Humidity** 40% to 90%

non-condensing) (operating)

Speaker cable length Input cord: 5.91 ft (1800mm±35mm)

L-channel cord: 3.28 ft (1000mm±35mm)

USB cord: 5.91 ft (1800mm±35mm)

HP Carbonite Color



Technical Specifications - Communications

Integrated Intel 82567LM Connector
Gigabit Network Controller
Connection ...

Connector RJ-45

Controller Intel 82567LM Gigabit platform LAN Connect Networking Controller

Memory Integrated 96KbB on chip buffer memory

Data rates supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3 ab and 802.3u compliant

Bus architecture GLCI, LCI interface. Intel specific MAC to PHY interface

Data transfer mode At gigabit GLCI (802.3 serdes) is for Data, LCI (parallel bus) for MDIO, at 10/100

LCI for both data and MDIO, GLCI is idle.

Hardware certifications FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark for

European Union

Power requirement Require 3.3Vaux, 1.8V and 1.0V or just 3.3V with integrated regulators

Power consumption 1.16 Watts for 82566, whole LOM 2.53 Watts

ACBS Intel Auto Connect Battery Saving feature

Boot ROM support Yes

Network transfer mode Full-duplex

Half-duplex (not available for the 1000BASE-T transceiver)

Network transfer rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Environmental Operating temperature 32° to 131°F (0° to 55° C)

To 70° C for external regulator

Operating humidity 85% at 131° F (55° C)

Management capabilities WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced cable

diagnostic.

Alerting ASF 2.0 support, AMT 3.0 support



Technical Specifications - Communications

Intel Gigabit CT Desktop NIC **Connector** RJ-45

Controller Intel WG82574L Gigabit Ethernet Controller

Memory Integrated Dual 48K configurable transmit receive FIFO Buffers

Data rates supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802,1Q, 802.2, 802.3, 802.3AB and 802.3u compliant, 802.3x

flow control

Bus architecture PCI-E 1.0a

Data path width X1, 250 MB/s, Bi-directional interface

Data transfer mode Bus-master DMA

Hardware certifications FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark for

European Union

Power requirement Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T

Boot ROM support Yes

Network transfer rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Environmental Operating temperature 32° to 131°F (0° to 55° C)

Operating humidity 85% at 131° F (55° C)

Dimensions 4.75 x 2.25 x 0.8 in (12.1 x 5.7 x 2.0 cm)

Operating system driver

support

Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows XP Professional or Windows XP Home 32*. No driver is required for this device. Native support is provided by the operating system.

Red Hat Linux 7.2, Linux 7.3 and Red Hat Enterprise Linux 3

* Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/upgradeadvisor. For Windows Vista

system requirements, visit:

http://www.windowsvista.com/systemrequirements.

Management capabilities WOL, PXE, DMI, WFM 2.0



Technical Specifications - Communications

Intel Pro 1000 PT PCIe Gigabit NIC **Connector** RJ-45

Controller Intel 82572EI Gigabit Ethernet Controller

Memory Integrated Dual 48K configurable transmit receive FIFO Buffers

Data rates supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802,1Q, 802.2, 802.3, 802.3AB and 802.3u compliant, 802.3x

flow control

Bus architecture PCI-E 1.0a

Data path width X1, 250 MB/s, Bi-directional interface

Data transfer mode Bus-master DMA

Hardware certifications FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark for

European Union

Power requirement Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T

Boot ROM support Yes

Network transfer rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps

1000BASE-T (full-duplex) 2000 Mbps (actual rate limited by PCI Bus)

Environmental Operating temperature 32° to 131°F (0° to 55° C)

Operating humidity 85% at 131° F (55° C)

Dimensions 6.4 x 2.6 x 0.8 in (16.3 x 6.6 x 1.9 cm)

Management capabilities WOL, PXE, DMI, WFM 2.0

HP 802.11b/g/n Wireless Dimensions (L x H)
PCIe x1 Card Weight

Dimensions (L x H) 3.3 x 4.7 inches (8.5 x 12 cm)

Weight 0.08 pounds (40 g)
Controller Ralink RT2790
System interface PCIExpress x1
Network standard 802.11 b/g/n
Frequency band 2.400 - 2.497 GHz

Operating temperature 14° to 149°F, operating (–10° to 65°C, operating)

Storage temperature –40° to 176°F, non-operating (-40° to 80°C, non-operating)

Humidity 10–90% operating

5–95% non-operating

Operating voltage 3.3V +/- 9%

12V +/- 8%

Power consumption Platform/WLAN Mode Power Consumption

Maximum Power 10 Watts

Consumption

Transmit Only 4 Watts maximum averaged power over 1 second

Transmit Packet or Active 1000 mA peak current for 100 microseconds or

Scanning longer

Technical Specifications - Communications

	_		
	Receive Only Mode or Idle without IEEE PSP mode enabled	1.0 Watts maximum averaged over 1 second 50 mW maximum, averaged over 1 second 5 mW maximum, averaged over 1 second	
	Idle, with IEEE PSP mode enabled		
	Transmit Disabled (turned off in software)		
	Platform in S3 or S4 (power removed from Low Profile PCI Express Card)		
Output power	802.11b modes	802.11g modes	EWC modes
(approximately)	+19 dBm +/- 1.0 dB maximum	+17 dBm +/- 1.0 dB maximum	+17 dBm +/- 1.0 dB maximum (total power in all transmit chains)
Receive sensitivity	Mode	Data rate	Sensitivity
	802.11b	1 Mbps	-94 dBm
	802.11b	11 Mbps	-85 dBm
	802.11g	6 Mbps	-91 dBm
	802.11g	18 Mbps	-85 dBm
	802.11g	48 Mbps	-75 dBm
	802.11g	54 Mbps	-72 dBm
	EWC (2.4 GHz)	6.5 Mbps	-87 dBm
	EWC (2.4 GHz)	54 Mbps	-82 dBm
	EWC (2.4 GHz)	81 Mbps	-78 dBm
	EWC (2.4 GHz)	162 Mbps	-74 dBm
	EWC (2.4 GHz)	270 Mbps	-68 dBm
	EWC (2.4 GHz)	300 Mbps	-64 dBm
Data transfer rate	Data Rate (MCS)	Minimum Throughput	İ
	1 Mbps (802.11 b)	700 kbps	
	2 Mbps (802.11 b)	1.4 Mbps	
	5.5 Mbps (802.11 b)	3.5 Mbps	
	11 Mbps (802.11 b)	5.9 Mbps	
	12 Mbps (802.11 g)	6 Mbps	
	18 Mbps (802.11 g)	9 Mbps	
	24 Mbps (802.11 g)	12 Mbps	
	36 Mbps (802.11 g)	18 Mbps	
	48 Mbps (802.11 g)	21 Mbps	
	54 Mbps (802.11 g)	22.5 Mbps	
	6.5 Mbps (20 MHz EWC)	4.5 Mbps	
	13 Mbps (20 MHz EWC)	9 Mbps	
	19.5 Mbps (20 MHz EWC)	13.5 Mbps	
	26 Mbps (20 MHz EWC)	18 Mbps	



Technical Specifications - Communications

39 Mbps (20 MHz EWC) 27 Mbps 52 Mbps (20 MHz EWC) 36 Mbps 58.5 Mbps (20 MHz EWC) 40 Mbps 65 Mbps (20 MHz EWC) 45 Mbps 78 Mbps (20 MHz EWC) 54 Mbps 104 Mbps (20 MHz EWC) 72 Mbps 117 Mbps (20 MHz EWC) 81 Mbps 130 Mbps (20 MHz EWC) 91 Mbps 13.5 Mbps (40 MHz EWC) 8 Mbps 27 Mbps (40 MHz EWC) 16 Mbps 40.5 Mbps (40 MHz EWC) 24 Mbps 54 Mbps (40 MHz EWC) 32 Mbps 81 Mbps (40 MHz EWC) 48 Mbps 108 Mbps (40 MHz EWC) 64 Mbps 121.5 Mbps (40 MHz EWC) 72 Mbps 135 Mbps (40 MHz EWC) 81 Mbps

Security

- IEEE and WiFi compliant 64 / 128 bit WEP encryption
- AES: CCM
- 802.1x authentication
- WPA: 802.1x. WPA-PSK and TKIP
- WPA2 certification
- IEEE 802.11i
- Cisco Certified Extensions, all versions through V5

Antenna HP part number 497792-001

Certifications

Wi-Fi certified

Certifications for use by

country

United States, Canada, Peru, Taiwan

Intel WiFi Link 5100 a/b/g/n (USDT) Wireless NIC Wireless LAN Standards IEEE 802.11a

IEEE 802.11b

IEEE 802.11n (draft 2.0)*

* The specifications for 802.11n draft 2.0 are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11n WLAN devices. In countries where n draft 2.0 is not allowed, this capability is not enabled.

enableu.

Interoperability Wi-Fi certified (802.11abg only)

Cisco Compatible Extensions Program compliant (802.11abg only) with

Microsoft Windows Vista and XP

Tested with wireless access points from several major manufacturers

Frequency Band 2.4 GHz and 5 GHz

Antenna Structure 1 transmit; 2 receive (1x2)



Technical Specifications - Communications

Data Rates 802.11b: 1, 2, 5.5, 11 Mbps

802.11a/g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n (draft): 66 possible data rates, ranging from 6 Mbps to 300 Mbps, depending on the combination of Bandwidth, Modulation Coding Scheme, and

Guard Interval used, as defined in IEEE 802.11n (draft) specification

Modulation Direct Sequence Spread Spectrum

DBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAM

Security¹ Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES

(support for key sizes of 128, 192, and 256 bits), 802.1x authentication types

EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-MSCHAPv2, LEAP, EAP-FAST.

Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program

Version 4) with Microsoft Windows Vista and XP only.

Sub-channels Multinational support with frequency bands and channels compliant to local

regulations.

Media Access Protocol CSMA/CA (Collision Avoidance) with ACK

Network Architecture

Ad-hoc (Peer to Peer)

Models

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

Output Power (for CCK)² 15 dBm Output Power (for OFDM; 15 dBm

power varies by data rate)2

Power Consumption Transmit: 2.3 Watts (average, with one spatial streams)

Receive: 1.9 Watts (average with two receive chains)

Idle mode³: 30 mW (average) Radio off: 20 mW (max)

Power Management ACPI compliant power management

802.11 compliant power saving mode

Receiver Sensitivity⁴ 300 Mbps: -68 dBm, 54 Mbps: -74 dBm, 6 Mbps: -90 dBm **Antenna Connections** 3 U.FL type connectors, 50 ohm nominal impedance

Range 802.11 a – Typical 600 feet – Outdoor Open Area

(@6 Mbps) 150 feet – Indoor, Office environment

802.11 b – Typical 1200 feet – Outdoor Open Area (@1 Mbps) 300 feet – Indoor, Office environment

802.11 q – Typical 1200 feet – Outdoor Open Area

(@1 Mbps) 300 feet – Indoor, Office environment

Form Factor PCI-Express MiniCard

Weight 0.013 lb (6 g)

Dimensions 0.19 x 1.2 x 2.0 in (4.75 x 29.85 x 50.8 mm)

Operating Voltage 3.3V +/- 9%, 1.5V +/- 5%

Temperature Operating 32° to 176° F (0° to 80° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 90% (non-condensing)

Technical Specifications - Communications

 Altitude
 Operating
 0 to 10,000 ft (3,048 m)

 Non-operating
 0 to 50,000 ft (15,240 m)

Configuration Utility⁵ Microsoft Windows XP

Choice of Configuration Utility:

Microsoft Windows XP Wireless Network Connection Manager

 Intel PROSet for Microsoft Windows XP (required for Cisco Compatible Extensions support)

Microsoft Windows Vista

Microsoft Windows Vista Wireless Network Connection Manager.

 Intel IHV extensions for Windows Vista available to support Cisco Compatible Extensions.

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. In Power Save Polling mode and on battery power.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

 WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista.

Agere 2006 PCI 56K International SoftModem

Data Transmission Technology speeds: 56,000 Kbps maximum downstream data, controllerless

NOTE: 56 Kbps technology refers to download speeds only and requires compatible modems at server sites. Other conditions may limit modem speed. FCC limitations allow a maximum of 53 Kbps during download transmissions.

Data Speeds (Upload only) 33,600/31,200/28,800/26,400/21,600/19,200/

16,800/14,400/12,000/9,600/7,200/4,800/2,400/1,200/300

Data Standards ITU-T V.90, ITU-T, ITU-T V.34, V.44, V.42, V.42bis21, V.32bis, Bell 212A, and

Bell 103

Fax Speeds 14,400/12,000/9,600/7,200/4,800/2,400/1,200/300 b/s

Fax Mode Capabilities ITU-T T.31 class 1 FAX, V. 17, V.29, V.27ter, and V.21 Channel 2

Error Correction and Data V.44, 42bis, V.42 and MNP2-5

Compression

Power Management ACPI; PPMI 1.1 and wake support with PME and Vaux; meets PCI 2.3

requirements and PC 2001 requirements

Upgradeability Driver upgradeable for future enhancements

Video ITU-T V.80 video ready interface

Other TIA/EIA 602 standard AT command set

Integrated DTE interface with speeds of up to 115.2 Kbps, parallel 16550a

UART-compatible interface

Optional ring wakeup signal

Operating Temperature 32° to 158° F (0° to 70° C)

Operating Humidity 20% to 90%, non-condensing



Technical Specifications - Communications

Power Requires a 3.3-V auxiliary power rail on PCI bus

Uses only one PCI load (i.e., one grant/request pair), one shared IRQ, one

electrical load

Chipset Agere Systems SV92PL – Integrated PCI interface with 5-V tolerant buffers

and CardBus support

Dimensions (L X H) Complies with PCI low profile specifications-6.7 x 2.3 in (17.0 x 5.8 cm) and

supports high- and low-profile brackets

Connection Single RJ-11 connector

Other Features Digital line protection, call progress monitoring via on-board piezo device,

support for high profile and low profile brackets, PnP ID support

Safety UL recognized to UL 1950, 3rd edition (U.S. and Canada); IEC 950 (TUV, NEMKO,

DEMKO, SEMKO); CE Mark, EC 950 (TUV, NEMKO, DEMKO, SEMKO, CE mark

EMC FCC Part 15, IC ES003, EN 55022, 3rd edition, EN 55024, annex A, EN 61000-4-

6, EN 61000-4-8

Telecom FCC Part 68, IC-CS-03 (Canada); Worldwide PTT approvals

Not available in Korea or the Republic of South Africa.

HealthBare PCB material compliant to 94V-0 or better (marked as such)OtherPC 2001 compliant, PCI version 2.3, WHQL approved; ACPI compliant



Technical Specifications - Graphics

Integrated Intel Graphics Media Accelerator 4500 3D/2D Controller
VGA Controller
DisplayPort

DisplayPort Bus Type

RAMDAC Memory Microsoft DirectX® 10 based with support for Pixel Shader 3.0

Integrated

Integrated, Multimode capable; supports HDCP

PCI Express™ x16

Integrated, 350 MHz

Graphics memory is shared with system memory. Graphics memory usage varies depending on the amount of system memory installed, BIOS settings, operating system, and system load. 32 MB is pre-allocated for graphics use at system boot time. Additional memory can be allocated at boot time by the BIOS for PAVP (Protected Audio Video Playback) support for playback of protected video content. For Vista, use of PAVP heavy mode preallocates an additional 96MB.

Additional memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide an optimal balance between graphics and system memory use.

Windows XP Memory Usage:

Total System Memory	Pre-Allocated (MB)	DVMT (MB)
.5GB	32	128
1.0GB	32	512
1.5GB	32	768
2 GB & more	32	1024

Windows Vista Memory Usage:

		Avail	Total Avail	Dedicated	System	Shared
System	System PVAP	System	GFX	Video	Video	System
Memory	PVAP	Memory	Memory	Memory	Memory	Memory
		(MB)	(MB)	(MB)	(MB)	(MB)
1 CD	Lite	952	252	32	96	124
1 GB	Heavy	856	294	122	6	166
2 GB	Lite	1976	764	32	96	636
2 45	Heavy	1880	806	122	6	678
4 GB	Lite	4024	1759	32	96	1631
4 00	Heavy	3928	1759	122	6	1631
6 GB	Lite	6072	1759	32	96	1631
O GB	Heavy	5976	1759	122	6	1631
0 CD	Lite	8120	1759	32	96	1631
8 GB	Heavy	8024	1759	122	6	1631

Total Available GFX Memory: Total graphics memory available to the system as reported by the OS.

Dedicated Video Memory: Memory owned and locked for graphics use as reported by the OS. (Preallocated)



Technical Specifications - Graphics

System Video Memory: System memory locked and dedicated for graphics use.

Shared System Memory: Memory dynamically allocated for Graphics use

HW Video Decode Hardware Accelerated decode for MPEG2 encrypted video; support for PAVP Lite

(default) and Heavy (or Paranoid) modes

Maximum Colour Depth 32 bits/pixel

Maximum Vertical Refresh Rate 85 Hz at up to 1920x1440, 75 Hz at 2048x1536. Varies with mode and configuration.

See table below.

Multi-display Support Dual monitor support facilitated via one VGA port and one DisplayPort integrated on

the back plane of the system board and presented as part of the rear I/O set of

interfaces. DVI supported via optional HP DisplayPort to DVI-D adapter.

Graphics/Video API Support Microsoft DirectX® 10, OpenGL® 1.5 (OpenGL® 2.0 available in a driver update)

Resolutions Supported

NOTE: Other resolutions may be available but are not recommended as the may not have been tested and qualified by HP.

	Maximum Ref	resh Rate (Hz)
Resolution	Analog Connection	Digital Connection
640x480	85	60
800x600	85	60
1024x768	85	60
1280x720	85	60
1280x1024	85	60
1440x900	75	60
1600x1200	85	60
1680x1050	75	60
1920x1080	85	60-R
1920x1200	85	60-R
1920x1440	85	N/A
2048x1536	75	N/A
2560x1600	N/A	60*

^{*} Only supported when using a DisplayPort connection

NOTE: 60-R denotes reduced blanking timings are used on single-link DVI connections and may be used with other digital connections

ATI Radeon HD 2400XT Bus type PCI Express (x16 lanes)

(256MB DH) PCIe Graphics Maximum vertical refresh rate 85 Hz

Card Display support Integrated 400 MHz RAMDAC

Display max resolution 1900 x 1200 digital, 2048 x 1536 analog

ATI Radeon HD 2400XT (256MB DH) PCIe Graphics Card display resolutions and refresh rates

NOTE: Other resolutions may be available but are not recommended as the may not have been tested and qualified by HP



Technical Specifications - Graphics

	Maximum Refresh Rate (Hz)		
Resolution	Analog Connection	Digital Connection	
640x480	85	60	
800x600	85	60	
1024x768	85	60	
1280x720	85	60	
1280x1024	85	60	
1440x900	75	60	
1600x1200	85	60	
1680x1050	75	60	
1920x1080	85	60-R	
1920x1200	85	60-R	
1920x1440	85	N/A	
2048x1536	75	N/A	
2560x1600	N/A	60*	

^{*} Only supported when using a dual-link DVI or DP connection

NOTE: 60-R denotes reduced blanking timings are used on single-link DVI connections and may be used with other digital connections

Board display options	Supports two displays via included DMS-59 to dual VGA cable or 2 DV
-----------------------	---

monitors via optional DMS-59 to dual DVI cable kit part number: DL139A. 4-

pin mini-DIN S-video connector for TV output

Board configuration	Specification	Description	
	Graphics Chip	RV610	
	Core clock	650 MHz	
	Memory clock	500 MHz	
	Frame buffer	256 MB DDR2, 128 bit wide	
Languages supported	24 languages: English, Arabic, Chinese Simplified, Chinese Traditional, Czechoslovakian, Danish, Dutch, Finnish, French, German, Greek, Hebrew, Hungarian, Italian, Japanese, Korean, Norwegian, Polish, Portuguese, Russian, Spanish, Swedish, Thai, Turkish		
Core power	21 W		
Compliance standards	EMC Emissions:		

- a. FCC Part 15, Subpart B Unintentional Radiators, Class B Computing Devices for Home & Office Use
- CISPR22: 1997/EN 55022:1998 Class B Limits and methods of measurement of radio disturbance characteristics of Information Technology Equipment
- c. Canadian Standard ICES-003 is equivalent to CISPR22
- d. Taiwanese Standard BSMI
- e. Japanese VCCI
- f. Australian C-Tick
- g. Korean (MIC)

EMC Immunity:

CISPR 24:1997/EN 55024:1998 – Information Technology Equipment – Immunity Characteristics – Limits and Methods of Measurement.



Technical Specifications - Graphics

ATI Radeon HD 3470 (256MB SH) PCIe x16 Graphics Card

Bus type PCI Express (x16 lanes)

Maximum vertical

85 Hz

refresh rate

Display support Integrated 400 MHz RAMDAC

Display max resolution 2560x1600 digital, 2048 x 1536 analog

ATI Radeon HD 3470 (256MB SH) PCIe x16 Graphics Card display resolutions and refresh rates NOTE: Other resolutions may be available but are not recommended as the may not have been tested and qualified by HP

	Maximum Ref	resh Rate (Hz)
Resolution	Analog Connection	Digital Connection
640x480	85	60
800x600	85	60
1024x768	85	60
1280x720	85	60
1280x1024	85	60
1440x900	75	60
1600x1200	85	60
1680x1050	75	60
1920x1080	85	60-R
1920x1200	85	60-R
1920x1440	85	N/A
2048x1536	75	N/A
2560x1600	N/A	60*

^{*} Only supported when using a dual-link DVI or DP connection

NOTE: 60-R denotes reduced blanking timings are used on single-link DVI connections and may be used with other digital connections

Board display options	Supports two dis	splays via the Di	splayPort and DVI connectors
-----------------------	------------------	-------------------	------------------------------

Board configuration	Specification	Description
	Graphics Chip	RV620
	Core clock	750 MHz
	Memory clock	500 MHz

Frame buffer 256 MB DDR2, 64 bit wide

Languages supported 24 languages: English, Arabic, Chinese Simplified, Chinese Traditional, Czechoslovakian,

Danish, Dutch, Finnish, French, German, Greek, Hebrew, Hungarian, Italian, Japanese, Korean, Norwegian, Polish, Portuguese, Russian, Spanish, Swedish, Thai, Turkish

Operating systems support

Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows XP Professional or Windows XP Home 32*.

* Certain Windows Vista product features require advanced or additional hardware.

Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit:

http://www.windowsvista.com/upgradeadvisor. For Windows Vista system requirements, visit: http://www.windowsvista.com/systemrequirements.

Technical Specifications - Graphics

Linux x86 and x86_64 distributions using XFree86 or X.Org**.

** Linux drivers are available from ATI's website and may be available in a Linux

distribution. Refer to the Open Source and Linux from HP website:

http://www.hp.com/wwsolutions/linux/products/clients/ for support information.

Core power 22 W (max)

Dimensions (H x D) 2.71 in x 6.60 in (68.90 mm x 167.65 mm)

Weight 0.30 lb (134.3 g)

Option kit contents ATI Radeon HD 3470 (256MB SH) PCIe x16 Graphics Card with full height bracket attached

DVI to VGA adapter

Software CD with graphics drivers

• Low profile bracket to convert the card for using in a low profile chassis

Warranty documentation

Compliance standards

EMC Emissions:

a. FCC Part 15, Subpart B - Unintentional Radiators, Class B Computing Devices for Home & Office Use

b. CISPR22: 1997/EN 55022:1998 - Class B - Limits and methods of measurement of radio disturbance characteristics of Information Technology Equipment

c. Canadian Standard ICES-003 is equivalent to CISPR22

d. Taiwanese Standard BSMI

e. Japanese VCCI

f. Australian C-Tick

g. Korean (MIC)

EMC Immunity:

CISPR 24:1997/EN 55024:1998 - Information Technology Equipment - Immunity Characteristics - Limits and Methods of Measurement.

ATI Radeon HD 3650 (512MB DH) PCIe x16

Graphics Card

Bus type

PCI Express (x16 lanes)

Maximum vertical refresh rate 85 Hz

Display support Integrated 400 MHz RAMDAC

Display max resolution 2560 x 1600 digital, 1920 x 1440 analog

Supports two displays via included two DisplayPort and one Dual Link DVII

connectors.

Board configuration Specification Description

> **Graphics Chip** RV635 Core clock 600 MHz Memory clock 500 MHz

Frame buffer 512 MB DDR2, 128 bit wide

Languages supported 24 languages: English, Arabic, Chinese Simplified, Chinese Traditional,

> Czechoslovakian, Danish, Dutch, Finnish, French, German, Greek, Hebrew, Hungarian, Italian, Japanese, Korean, Norwegian, Polish, Portuguese,

Russian, Spanish, Swedish, Thai, Turkish



Technical Specifications - Graphics

Core power 56 W

Compliance standards EMC Emissions:

- a. FCC Part 15, Subpart B Unintentional Radiators, Class B Computing Devices for Home & Office Use
- CISPR22: 1997/EN 55022:1998 Class B Limits and methods of measurement of radio disturbance characteristics of Information Technology Equipment
- c. Canadian Standard ICES-003 is equivalent to CISPR22
- d. Taiwanese Standard BSMI
- e. Japanese VCCI
- f. Australian C-Tick
- g. Korean (MIC)

EMC Immunity:

CISPR 24:1997/EN 55024:1998 – Information Technology Equipment – Immunity Characteristics – Limits and Methods of Measurement.

ATI Radeon HD 3650 (512MB DH) PCIe x16 Graphics Card display resolutions and refresh rates

NOTE: Other resolutions may be available but are not recommended as the may not have been tested and qualified by HP

	um Refresh Rate (Hz)
Desclution Apples Convertion	
Resolution Analog Connection	Digital Connection
640x480 85	60
800x600 85	60
1024x768 85	60
1280x720 85	60
1280x1024 85	60
1440x900 75	60
1600x1200 85	60
1680x1050 75	60
1920x1080 85	60-R
1920x1200 85	60-R
1920x1440 85	N/A
2048x1536 75	N/A
2560x1600 N/A	60*

* Only supported when using a dual-link DVI or DP connection

NOTE: 60-R denotes reduced blanking timings are used on single-link DVI connections and may be used with other digital connections



Technical Specifications - Graphics

NVIDIA Quadro NVS 290 256MB PCIe Dual Head

Form Factor Low Profile PCle x16 **Bus Type**

Memory 256 MB 400MHz DDR2 SDRAM unified frame buffer, Z-buffer and Texture

storage

DMS-59; includes one DMS-59 to Dual VGA cable. A DMS-59 to Dual DVI-I cable Connector

is available as an option.

Display resolution

support

Dual integrated analog display controllers supporting up to two analog displays at 2048x1536 @ 85Hz on both displays or dual digital displays at

1920x1200 (single-link).

NVIEW advanced multi-display desktop and application management

seamlessly integrated into Microsoft Windows

RAMDAC Integrated dual 400MHz Colour planes 32-bit colour buffer **Overlay planes** Hardware supported

nView architecture Advanced multi-display desktop & application management seamlessly

integrated into Microsoft Windows.

Multi-Monitor support

DVI support

Dual monitor support DMS-59 (to dual DVI-SL)

High-definition Video

Processor (HDVP)

Full-screen, full-frame video playback of HDTV and DVD content DVD-ready motion compensation for MPEG-2

Independent hardware colour controls for video overlay Hardware colour-space conversion (YUV 4:2:2 and 4:2:0)

IDCT motion compensation

5-tap horizontal by 3-tap vertical filtering

8:1 up/down scaling

Supported graphics APIs OGL 2.1 & DX10 Support; Shader Model 4.0

NVIDIA Quadro NVS 295 256MB PCIe Graphics Card Graphics Controller

2.731 inches (H) × 6.600 inches (L), Half-Height Form Factor

NVIDIA Quadro NVS 295 Graphics Board

PCI Express x16, Generation 2.0 **Bus Type**

Memory 256 MB GDDR3 SDRAM unified graphics memory

Connector 2 DisplayPort

Comes with 2 DisplayPort to VGA Adapters

NOTE: DisplayPort to DVI-D (Single Link) adapter available as an accessory

Maximum Resolution

Display Output

Two DisplayPort outputs drive two digital displays up to 2560 x 1600

 Drives DisplayPort enabled digital displays at resolutions up to 2560 x 1600 at 60 Hz with reduced blanking

Drives DVI enabled digital displays at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using optional DisplayPort to DVI-D (Single

Link) adapter

Supported Graphics APIs OpenGL 3.0

DirectX 10.0

Available Graphics

Drivers

Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Technical Specifications - Graphics

Power consumption

23 Watts



Technical Specifications - Hard Drives

2.5" 7200 RPM Serial ATA	250 GB
Hard Drives	

 Capacity
 250,059,350,016 bytes

 Height (Nominal)
 0.374 in (9.5 mm)

Width (Nominal) Media diameter: 2.5 in (63.5 mm)

Physical size: 2.75 in (70 mm)

Interface Serial ATA (3.0 Gb/s)

Synchronous Transfer

Rate (Maximum)

Up to 3 Gb/s

Cache 8 MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average2.0 msAverage
Full-Stroke12 ms22 ms

Rotational Speed 7,200 rpm **Logical Blocks** 488,397,168

Operating Temperature 41° to 131° F (5° to 55° C)

80 GB Capacity 80,026,361,856 bytes

Height (Nominal) 0.374 in (9.5 mm)

Width (Nominal) Media diameter: 2.5 in (63.5 mm)

Physical size: 2.75 in (70 mm)

Interface Serial ATA (3.0 Gb/s)

Synchronous Transfer

Rate (Maximum)

Up to 3 Gb/s

Cache 8 MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average2.0 ms
12 msAverage
Full-Stroke22 ms

Rotational Speed 7,200 rpm Logical Blocks 156,301,488

Operating Temperature 41° to 131° F (5° to 55° C)

3.5" 7200 RPM Serial ATA 500 GB

Hard Drives

Capacity 500,107,862,016 bytes

Height 1 in (2.54 cm)

Width Media diameter: 3.5 in (8.89 cm)

Physical size: 4 in (10.2 cm)

Interface Serial ATA (3.0 Gb/s)

Synchronous Transfer

Rate (Maximum)

Up to 3 Gb/s

Buffer 16 MB

Technical Specifications - Hard Drives

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average2.0 ms11 ms
21 ms

Rotational Speed 7,200 RPM Logical Blocks 976,773,168

Operating Temperature 41° to 131° F (5° to 55° C)

250 GB Capacity 250,059,350,016 bytes

Height 1 in (2.54 cm)

Width Media diameter: 3.5 in (8.89 cm)
Physical size: 4 in (10.2 cm)

Interface Serial ATA (3.0 Gb/s)

Synchronous Transfer

Rate (Maximum)

Up to 3 Gb/s

Buffer 8 MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average1.0 msAverage
Full-Stroke8.5 ms18 ms

Rotational Speed 7,200 RPM **Logical Blocks** 488,397,168

Operating Temperature 41° to 131° F (5° to 55° C)

80 GB Capacity 80,026,361,856 bytes

Height 1 in (2.54 cm)

Width Media diameter: 3.5 in (8.89 cm)

Physical size: 4 in (10.2 cm)

Interface Serial ATA (3.0 Gb/s)

Synchronous Transfer

Rate (Maximum)

Up to 3 Gb/s

Buffer 8 MB

Seek Time (typical reads, includes controller overhead, including

Single Track

Average

settling)

Average 9.3 ms Full-Stroke 21 ms

2.0 ms

Rotational Speed 7,200 RPM **Logical Blocks** 156,301,488

Operating Temperature 41° to 131° F (5° to 55° C)

Technical Specifications - Hard Drives

10,000 RPM Serial ATA Hard Drives 80 GB

Capacity 80,026,361,856 bytes

Height 1 in (2.54 cm)

Width Media diameter: 3.0 in (7.62 cm)

Physical size: 4 in (10.2 cm)

Interface Serial ATA (1.5 Gb/s), Native Command Queuing enabled

Synchronous Transfer

Rate (Maximum)

Up to 3.0 Gb/s

Cache 16 Mbytes

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average0.3 msAverage
Full-Stroke4.6 ms10.2 ms

Rotational Speed 10,000 RPM **Logical Blocks** 156,301,488

Operating Temperature 41° to 131° F (5° to 55° C)



Technical Specifications - Input/Output Devices

USB Standard Keyboard	Physical characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country)	
		Dimensions (L \times W \times H)	18.0 x 6.4 x 0.98 in (45.8 x 16.3 x 2.5 cm)	
		Weight	2 lb (0.9 kg) minimum	
	Electrical	Operating voltage	+ 5VDC ± 5%	
		Power consumption	50-mA maximum (with three LEDs ON)	
		System interface	USB Type A plug connector	
		ESD	CE level 4, 15-kV air discharge	
		EMI – RFI	Conforms to FCC rules for a Class B computing device	
		Microsoft® PC 99 – 2001	Functionally compliant	
	Mechanical	Languages	38 available	
		Keycaps	Low-profile design	
		Switch actuation	55-g nominal peak force with tactile feedback	
		Switch life	20 million keystrokes (using Hasco modified tester)	
		Switch type	Contamination-resistant switch membrane	
		Key-leveling mechanisms	For all double-wide and greater-length keys	
		Cable length	6 ft (1.8 m)	
		Microsoft PC 99 – 2001	Mechanically compliant	
		Acoustics	43-dBA maximum sound pressure level	
	Environmental	Operating temperature	50° to 122° F (10° to 50° C)	
		Non-operating temperature	-22° to 140° F (-30° to 60° C)	
		Operating humidity	10% to 90% (non-condensing at ambient)	
		Non-operating humidity	20% to 80% (non-condensing at ambient)	
		Operating shock	40 g, six surfaces	
		Non-operating shock	80 g, six surfaces	
		Operating vibration	2-g peak acceleration	
		Non-operating vibration	4-g peak acceleration	
		Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence	
		Drop (in box)	42 in (107 cm) on concrete, 16-drop sequence	
	Approvals	UL, CSA, FCC, CE Mark, TUV,	TUV GS, VCCI, BSMI, C-Tick, MIC	
	Ergonomic compliance	e ANSI HFS 100, ISO 9241-4, and TUVGS		
	Kit contents	Keyboard, installation guide, warranty card, safety and comfort guide		

Technical Specifications - Input/Output Devices

PS/2 Standard Keyboard	Physical characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country)	
		Dimensions (L \times W \times H)	18.0 x 6.4 x 0.98 in (45.8 x 16.3 x 2.5 cm)	
		Weight	2 lb (0.9 kg) minimum	
	Electrical	Operating voltage	+ 5VDC ± 5%	
		Power consumption	50-mA maximum (with three LEDs ON)	
		System interface	PS/2 6-pin mini din connector	
		ESD	CE level 4, 15-kV air discharge	
		EMI - RFI	Conforms to FCC rules for a Class B computing device	
		Microsoft PC 99 - 2001	Functionally compliant	
	Mechanical	Languages	38 available	
		Keycaps	Low-profile design	
		Switch actuation	55-g nominal peak force with tactile feedback	
		Switch life	20 million keystrokes (using Hasco modified tester)	
		Switch type	Contamination-resistant switch membrane	
		Key-leveling mechanisms	For all double-wide and greater-length keys	
		Cable length	6 ft (1.8 m)	
		Microsoft PC 99 - 2001	Mechanically compliant	
		Acoustics	43-dBA maximum sound pressure level	
	Environmental	Operating temperature	50° to 122° F (10° to 50° C)	
		Non-operating temperature	-22° to 140° F (-30° to 60° C)	
		Operating humidity	10% to 90% (non-condensing at ambient)	
		Non-operating humidity	20% to 80% (non-condensing at ambient)	
		Operating shock	40 g, six surfaces	
		Non-operating shock	80 g, six surfaces	
		Operating vibration	2-g peak acceleration	
		Non-operating vibration	4-g peak acceleration	
		Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence	
		Drop (in box)	42 in (107 cm) on concrete, 16-drop sequence	
	Approvals	UL, CSA, FCC, CE Mark, TUV,	TUV GS, VCCI, BSMI, C-Tick, MIC	
	Ergonomic compliance	ANSI HFS 100, ISO 9241-4,	and TUVGS	
HP USB Smartcard Keyboard	Physical characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country)	
		Form factor	USB basic Smart Card keyboard	



Dimensions $(H \times W \times D)$

Carbonite/Silver

18.2 x 6.3 x 1.3 in (46.3 x 16.1 x 3.3 cm)

Colours

Technical Specifications - Input/Output Devices

	Weight	2 lb (0.9 kg) minimum
Electrical	Operating voltage	+ 5VDC ± 5%
	Power consumption	100-mA maximum (with four LEDs ON)
	System interface	USB Type A plug connector
	ESD	CE level 4, 15-kV air discharge
	EMI - RFI	Conforms to FCC rules for a Class B computing device
	Microsoft PC 99 - 2001	Functionally compliant
Mechanical	Languages	30+ available
	Keycaps	Low-profile design
	Switch actuation	55 g nominal peak force with tactile feedback
	Switch life	20 million keystrokes (using Hasco modified tester)
	Switch type	Contamination-resistant membrane
	Key-leveling mechanisms	For all double-wide and greater-length keys
	Cable length	6 ft (1.8 m)
	Microsoft PC 99 - 2001	Mechanically compliant
	Acoustics	43-dBA maximum sound pressure level
Environmental	Operating temperature	50° to 122° F (10° to 50° C)
	Non-operating temperature	-22° to 140° F (-30° to 60° C)
	Operating humidity	10% to 90% (non-condensing at ambient)
	Non-operating humidity	20% to 80% (non-condensing at ambient)
	Operating shock	40 g, six surfaces
	Non-operating shock	80 g, six surfaces
	Operating vibration	2-g peak acceleration
	Non-operating vibration	4-g peak acceleration
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence
	Drop (in box)	42 in (107 cm) on concrete, 16-drop sequence
Approvals	CE-Mark, UL, CSA, FCC, CE N EMV2000, USB-IF, FIPS 201	Nark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC, JITC,
SMARTCARD function	Support	All ISO 7816 smart cards
	Interface	Reads from and writes to all ISO7816-1, 2, 3, 4 memory and microprocessor smart cards (T=0, T=1)
	Chipset	SCM STCII
	Standard APIs supported	PC/SC, EMV2000, SET



Technical Specifications - Input/Output Devices

Power USB Port

Short circuit detection (protects smart card and

reader)

Power supply compliant with ISO7816 and EMV

(5V, 60 mA)

Supports 3-V and 5-V cards

Power consumption 250-mA maximum draw (50 mA for the keyboard

> with three LEDs ON and 200-mA maximum startup current using a high-current, 60-mA smart

card)

Communication From card Programmable from

9,600 baud to 115,200

baud

From computer

Up to 38,400 baud

Landing mechanism Contact device Friction contact

> Up to 100,000 insertion Card insertions rating

cycles

Interface modes USB communications through USB port

SCM protocol

Automatic card insertion/removal detection

Reader performance

interface

USB connection

Electro-magnetic

standards

Europe

89/336/CEE guideline

USA USAFCC part 15

HP PS/2 Optical Scroll Mouse

Dimensions (H x L x W)

Weight

Environmental

4.44 oz (126 g)

Operating temperature

-32° to 104°F (0° to 40° C)

Non-operating

-4° to 140°F (-20° to 60° C)

temperature **Operating humidity**

10% to 90% (non condensing at ambient)

Non-operating humidity

10% to 90% non condensing

Operating shock Non-operating shock 40 g, 6 surfaces 80 g, 6 surfaces

Operating vibration

2 g peak acceleration

Non-operating vibration

4 g peak acceleration

Drop (out of box)

80 cm height onto asphalt tile over concrete or

equivalent, 5-drop in 5 direction except the cable

face

Electrical

Operating voltage 5 VDC ± 10%

3.95 x 6.21 x 11.7 cm (1.56 x 2.44 x 4.61 in)

Power consumption 100mA

System consumption

PS/2 mini-din connector

ESD

CE level 4, 15 kV air discharge

Technical Specifications - Input/Output Devices

Mechanical

EMI-RFI Conforms to FCC rules for a Class B computing

device

Microsoft PC99 - 2001 Functionally compliant

Resolution 400 ± 20% DPI

Tracking speed 10 in/s (25.4 cm/s) maximum

Acceleration100 in/s/s (2.54 m/s/s)Switch actuation61 g nominal peak force

Switch life 3,000,000 operations (using Hasco modified

tester)

Switch type Low force micro-switches

Tracking mechanism life 155 mi (250 km) at average speed of 10 in/s

Cable length 6 ft (1.8 m)

Microsoft PC99 - 2001 Mechanically compliant

Scroll wheel Width 8 mm

Compliant

Diameter 1.01 in (25.6 mm) **Maximum rotation speed** 48 rats/sec

Switch type Light force micro-switch

Switch life 1 million operations

Mechanical life Minimum 200,000 revolutions

UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-

Tick, MIC

HP USB Optical Scroll

Mouse

Dimensions (H x L x W)

Regulatory approvals

1.5 x 4.5 x 2.5 in (3.8 x 11.6 x 6.3 cm)

 Weight
 0.27 lb (0.12 kg)

 Cable length
 72.8 in (185 cm)

System requirements Microsoft Windows 95, 98, 2000, Me, XP and Vista

Available USB port



Technical Specifications - Optical Storage

HP SATA SuperMulti LightScribe DVD Writer Drive Height5.25-inch, half-height, tray-loadOrientationEither horizontal or vertical

Interface type SATA/ATAPI

Disc capacity 8.5 GB DL or 4.7 GB standard

Dimensions (W x H x D) 5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)

Weight (max) 2.6 lb (1.2 kg)

Write speeds DVD-RAM Up to 12X

DVD+R Up to 16X DVD+RW Up to 8X **DVD+RDL** Up to 8X **DVD-RDL** Up to 8X DVD-R Up to 16X **DVD-RW** Up to 6X CD-R Up to 48X CD-RW Up to 32X

Read speeds DVD-RAM Up to 12X

DVD+RW, DVD-RW, DVD+R Up to 8X

DL, DVD-R DL

DVD-ROM DL Up to 8X
DVD-ROM, DVD+R, Up to 16X

DVD-R

CD-ROM, CD-R Up to 48X CD-RW Up to 32X

Access time (typical reads, including

settling)

Random DVD: < 140 ms (typical), CD: < 125 ms (typical) **Full Stroke** DVD: < 250 ms (seek), CD: < 210 ms (seek)

Cache Buffer 2 MB (minimum)

Data Transfer Modes ATA PIO mode 4 (16.7 MB/s); ATA Multi-word DMA

mode 2 (16.7 MB/s); ATA UltraDMA Mode 3 (44.4

MB/s -default)

Power Source SATA DC power receptacle

DC Power Requirement 5 VDC ± 5%-100 mV ripple p-p

12 VDC ± 5%-200 mV ripple p-p

DC Current 5 VDC (< 1000 mA typical, 1600 mA maximum)

12 VDC (< 600 mA typical, 1400 mA maximum)

Environmental conditions Temperature 41° to 122° F (5° to 50° C)

(operating - non-

condensing)

Relative Humidity Maximum Wet Bulb

10% to 90% 86° F (30° C)

Temperature

Technical Specifications - Optical Storage

SATA DVD-ROM Drive	Height	5.25-inch, half-height, tray-load
	Orientation	Either horizontal or vertical

Interface type SATA/ATAPI

Disc capacity Single layer: Up to 4.7 GB (6 times capacity of CD-ROM)

Double layer: Up to 8.5 GB (12 times capacity of CD-ROM)

Dimensions (W x H x D) 5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)

Weight (max) 2.6 lb (1.2 kg)

Read speeds DVD+R/-R/+RW/ Up to 8X

-RW/+R DL /-R DL

DVD-ROM Up to 16X
DVD-RAM Up to 4X
CD-ROM, CD-R Up to 48X
CD-RW Up to 32X

Removable Storage -Media Compatibility -DVD-ROM Media Read Write CD-ROM Yes No CD-R Yes No CD-RW Yes No **DVD-ROM** Yes No **DVD-ROM DL** Yes No **DVD-RAM** Yes No DVD+R Yes No **DVD+RDL** Yes No **DVD+RW** Yes No DVD-R Yes No **DVD-RW** Yes No **DVD-RDL** Yes No

Access times

(typical reads, including

setting)

RandomDVD: < 140 ms (typical), CD: < 125 ms (typical)</th>Full StrokeDVD: < 250 ms (seek), CD: < 210 ms (seek)</th>

Cache Buffer 2 MB (minimum)

Data Transfer Modes ATA PIO mode 4 (16.7 MB/s); ATA Multi-word DMA

mode 2 (16.7 MB/s); ATA UltraDMA Mode 3 (44.4

MB/s -default)

Power Source SATA DC power receptacle

DC Power Requirement 5 VDC ± 5%-100 mV ripple p-p

12 VDC ± 5%-200 mV ripple p-p

DC Current 5 VDC - <1000 mA typical, < 1600 mA maximum

12 VDC -< 600 mA typical, < 1400 mA maximum

Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions non-condensing)

Relative Humidity 10% to 90%

Maximum Wet Bulb 86° F (30° C)

Temperature



Technical Specifications - Optical Storage

SATA Slim SuperMulti LightScribe DVD Writer Drive **Height** 12.7mm height

Orientation Either horizontal or vertical

Interface type SATA/ATAPI

Disc recording capacity Up to 8.5 GB DL or 4.7 GB standard **Dimensions** (W x H x D) 5.0 x 0.5 x 5.0 in (128 x 13.6 x 129 mm)

Weight (max) 0.42 lb (190 g)

Write speeds DVD-RAM Up to 5X

DVD-R DL Up to 4X DVD+R Up to 8X DVD+RW Up to 4X **DVD+RDL** Up to 4X DVD-R Up to 8X **DVD-RW** Up to 6X CD-R Up to 24X CD-RW Up to 16X

Read speeds DVD-RAM Up to 5X

 DVD-RW, DVD+RW
 Up to 8X

 DVD-R DL, DVD+R DL
 Up to 6X

 DVD+R, DVD-R
 Up to 8X

 DVD-ROM DL, DVD-ROM
 Up to 8X

 CD-ROM, CD-R
 Up to 24X

 CD-RW
 Up to 24X

Access time

(typical reads, including

settling)

Random DVD: < 140 ms (typical), CD: < 125 ms (typical) **Full Stroke** DVD: < 250 ms (seek), CD: < 210 ms (seek)

Stop Time< 4 seconds</th>Cache Buffer2 MB (minimum)

Data Transfer Modes ATA PIO mode 4 (16.7 MB/s); ATA Multi-word DMA

mode 2 (16.7 MB/s); ATA UltraDMA Mode 3 (44.4

MB/s - default)

Power Source Four-pin, DC power receptacle

DC Power Requirement 5 VDC ± 5%-100 mV ripple p-p

12 VDC ± 5%-200 mV ripple p-p

DC Current 5 VDC (< 1000 mA typical, 1600 mA maximum)

12 VDC (< 600 mA typical, 1400 mA maximum)

Total Drive Power < 2.5 Watt

(standby mode)



Technical Specifications - Optical Storage

Audio output Line-Out **0.7 VRMS**

> Signal-to-Noise Ratio 74 dB **Channel Separation** 65 dB

Environmental conditions Temperature 41° to 122° F (5° to 50° C)

(operating - noncondensing)

Relative Humidity 10% to 90% **Maximum Wet Bulb** 86° F (30° C)

Temperature

SATA CD-RW/DVD-ROM **Combo Slim Drive**

Height 12.7mm height slim CD-RW Orientation Either horizontal or vertical

Interface type SATA/ATAPI

Disc capacity Single layer: Up to 4.7 GB (6 times capacity of CD-ROM)

Dimensions (W \times H \times D) 5.0 x 0.5 x 5.0 in (128 x 13.6 x 129 mm)

Weight (max) 0.42 lb (190 g)

Write speeds CD-R Up to 24X

> CD-RW Up to 24X

Read speeds DVD+R/-R/+RW/ Up to 4X

-RW/+R DL /-R DL

DVD-ROM Up to 8X CD-ROM, CD-R Up to 24X CD-RW Up to 24X

Access time

(typical reads, including

settling)

condensing)

Random DVD DVD: < 140 ms (typical), CD: < 125 ms (typical) Random CD DVD: < 250 ms (typical), CD: < 210 ms (typical)

Cache Buffer 2 MB (minimum)

Data Transfer Modes ATA PIO mode 4); ATA Multi-word DMA mode 2;

ATA UltraDMA mode 0; ATA UltraDMA mode 1. mode 2; ATA UltraDMA Mode 3 (default)

Power Source Four-pin, DC power receptacle

> **DC Power Requirement** 5 VDC ± 5%-100 mV ripple p-p

DC Current 5 VDC (< 1000 mA typical, < 1600 mA maximum)

Total Drive Power < 2.5 Watt

(standby mode)

Audio output level 0.7 Vrms (typical)

Environmental (all **Temperature** conditions non-

41° to 122° F (5° to 50° C)

Relative Humidity 5% to 85% **Maximum Wet Bulb** 86° F (30° C)

Temperature (operating)

Technical Specifications - Optical Storage

SATA DVD-ROM Slim Drive Height 12.7mm

settling)

Orientation Either horizontal or vertical

Interface type SATA/ATAPI

Dimensions (W x H x D) 5.0 x 0.5 x 5.0 in (128 x 13.6 x 129 mm)

Weight (max) 0.42 lb (190 g)

Read speeds DVD+R/-R/+RW/ Up to 4X

-RW/+R DL /-R DL

DVD-ROM Up to 8X
CD-ROM, CD-R Up to 24X
CD-RW Up to 24X

Access time Random DVD DVD: < 140 ms (typical), CD: < 125 ms (typical) (typical reads, including Pandom CD DVD: < 250 ms (seek), CD: < 210 ms (seek)

Data Transfer Modes ATA PIO mode 4 (16.7 MB/s); ATA Multi-word DMA

mode 2 (16.7 MB/s)

Power Source Four-pin, DC power receptacle

DC Power Requirement 5 VDC ± 5%-100 mV ripple p-p

DC Current 5 VDC - <1000 mA typical, < 1600 mA maximum

Total Drive Power < 2.5 Watt

(standby mode)

Audio output Line-Out 0.7 VRMS

Signal-to-Noise Ratio 74 dB
Channel Separation 65 dB

Environmental (all **Temperature** 41° to 122° F (5° to 50° C)

conditions noncondensing) Relative Humidity 5% to 85% Maximum Wet Bulb 86° F (30° C)

Temperature (operating)

Technical Specifications - Removable Storage

HP 22-in-1 (with 1394) **Media Card Reader**

USB Interface USB 2.0 High-speed interface

NOTE: Requires the USB cable to be connected to the internal USB 2.0 port or

a USB 2.0 PCI card.

1394 Interface Two IEEE-1394a external ports; 1 IEEE-1394a internal port (connects to the

pass through cable on the media card reader)

Advance protocol support

Supports hardware ECC (Error Correction Code) function

Supports hardware CRC (Cyclic Redundancy Check) function

Supports MS 4-bit parallel transfer mode

Supports MS-PRO 4-bit parallel transfer mode

Supports MS PRO-HG Duo 4-bit parallel transfer mode

Supports SD 4-bit parallel transfer mode

Supports high-speed 50Mhz SD 4-bit card (version 2.0)

Supports high-speed 52Mhz MultiMediaCard 8-bit card (version 4.2)

Supports CF v4.0 with PIO mode 6 and Ultra DMA mode

Supported media type

CompactFlash Type I

CompactFlash Type II

Microdrive

MultiMediaCard

Reduced Size MultiMediaCard (RS MultiMediaCard)

MultiMediaCard 4.2 (MultiMediaCard Plus, including MultiMediaCard Plus HC)

Reduced Size MultiMediaCard 4.2 (MultiMediaCard Mobile, including MultiMediaCard Mobile HC)

Secure Digital Card (SD)

Secure Digital High Capacity (SDHC)

miniSD

miniSD High Capacity

Micro SD (T-Flash)

Micro SD HC

Memory Stick

Memory Stick Select

Memory Stick Duo (MS Duo)

Memory Stick PRO (MS PRO)

Memory Stick PRO Duo (MS PRO Duo)

Memory Stick PRO-HG Duo

MagicGate Memory Stick (MG)

MagicGate Memory Stick Duo

Picture Card

Supported media type with card adapter

Environmental

Memory Stick Micro (M2)

MultiMediaCard Micro

Operational Environmental Extremes operating on system ±5%

Test Parameters/Conditions - Power applied, unit

nominal supply voltage. 10°C 10% R.H. ? 24 hours 10°C 90% R.H. ? 24 hours 20°C 90% R.H. ? 24 hours 30°C 90% R.H. ? 24 hours

40°C 90% R.H. ? 24 hours

Technical Specifications - Removable Storage

50°C 90% R.H. ? 24 hours

50°C 10% R.H. ? 24 hours

Storage Environmental

Extremes

Test Parameters/Conditions

140°F (60°C) @ 80% R.H. for 96 hours -22°F (-30°C) @ 20% R.H. for 48 hours

No power applied Delta °C < 1.0°C/min

Delta % R.H. < 1.5% R.H./min

Approvals USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport

Specification Rev. 1.0, Compliant Intel Front Panel I/O Connectivity Design

Guide V. 1.3

FCC, CE, BSMI, C-Tick, VCCI, MIC, cUL, TUV-T



Technical Specifications - Environmental Data

Eco-Label Certifications & This product has received or is in the process of being certified to the following approvals and may be declarations labeled with one or more of these marks:

- US ENERGY STAR ®
- IT ECO declaration
- EPEAT Gold¹

NOTE: This product conforms to the examination standards (2003 version) under JEITA's 'PC Green Label System.'

¹ EPEAT certification is conditional upon ENERGY STAR qualification. Only dc7900e models which qualify for ENERGY STAR will be certified EPEAT – Gold

Ultra-Slim Desktop

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Ultra-slim Desktop model is based on a typically configured product

Energy Consumption	115 VAC	230 VAC	100 VAC
Normal Operation	40.68 W	40.07 W	39.94 W
Sleep (Energy Star low power mode)	2.95 W	2.96 W	2.96 W
Off	1.67 W	1.68 W	1.68 W
Heat Dissipation*	115 VAC	230 VAC	100 VAC
Normal Operation	139 BTU/hr	137 BTU/hr	137 BTU/hr
Sleep	10 BTU/hr	10 BTU/hr	10 BTU/hr
Off	6 BTU/hr	6 BTU/hr	6 BTU/hr

^{*} Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

This product is in compliance with US executive order 13221, WOL (wake on LAN) disabled.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)

System Fan Off	Sound Power (LWAd, bels)	Sound Pressure (LpAm, decibels)
Idle	3.1	23
Fixed Disk (random writes)	3.1	24
Optical Drive (sequential reads)	4.8	42

Batteries This product complies with ISO standards:

- EU Directive 91/157/EEC
- EU Directive 93/86/EEC
- EU Directive 98/101/EEC



Technical Specifications - Environmental Data

Batteries used in the product do not contain:

- Mercury greater the 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 4000ppm by weight.

Battery size: CR2032 (coin cell)

Battery type: Lithium

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive 2002/95/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE)
 Directive 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level¹, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 0% recycled materials (by wt.)
- This product is 90.6% recyclable when properly disposed of at end of life.

Packaging Materials

- External:
 - Corrugated carton 1476 g
 - O Polyethylene low density 105 g
 - Wood(pallet) 13,000 g
- Internal:
- The EPE foam packaging material is made from 100% recycled content.
- The corrugated paper packaging materials contains at least 100% recycled content.

Small Form Factor

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Small Form Factor Desktop model is based on a typically configured product

Energy Consumption	115 VAC	230 VAC	100 VAC
Normal Operation	55.58 W	56.06 W	58.60 W
Sleep (Energy Star low power mode)	2.47 W	2.76 W	2.51 W
Off	1.23 W	1.51 W	1.26 W
Heat Dissipation*	115 VAC	230 VAC	100 VAC
Normal Operation	190 BTU/hr	192 BTU/hr	200 BTU/hr
Sleep	8 BTU/hr	9 BTU/hr	8 BTU/hr
Off	4 BTU/hr	5 BTU/hr	4 BTU/hr



¹ EPEAT certification is conditional upon ENERGY STAR qualification. Only dc7900e models which qualify for ENERGY STAR will be certified EPEAT – Gold.

Technical Specifications - Environmental Data

* Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

This product is in compliance with US executive order 13221, WOL (wake on LAN) disabled.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)

"Typical Configuration" with 7200 rpm HDD

	Sound Power	Sound Pressure
System Fan Off	(LWAd, bels)	(LpAm, decibels)
Idle	3.7	27
Fixed Disk	3.8	28
(random writes)		

Configuration with optional 10,000 rpm HDD

	Sound Power	Sound Pressure
System Fan Off	(LWAd, bels)	(LpAm, decibels)
Idle	3.8	27
Fixed Disk	4.2	32
(random writes)		

Batteries

This product complies with ISO standards:

- EU Directive 91/157/EEC
- EU Directive 93/86/EEC
- EU Directive 98/101/EEC

Batteries used in the product do not contain:

- Mercury greater the 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 4000ppm by weight.

Battery size: CR2032 (coin cell)

Battery type: Lithium

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive 2002/95/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE)
 Directive 2002/96/EC.
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level¹, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 0% recycled materials (by wt.)
- This product is 93.4% recyclable when properly disposed of at end of life.

Packaging Materials

- External:
 - Corrugated 1736 g
 - Polyethylene low density foam 35 g



Technical Specifications - Environmental Data

- Internal:
 - O EPE-Expanded Polyethylene 293 g
- The EPE foam packaging material is made from 0% recycled content.
- The corrugated paper packaging materials contains at least 25% recycled content.

¹ EPEAT certification is conditional upon ENERGY STAR qualification. Only dc7900e models which qualify for ENERGY STAR will be certified EPEAT – Gold.

Convertible Minitower

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Convertible Mini tower Desktop model is based on a typically configured product

Energy Consumption	115 VAC	230 VAC	100 VAC
Normal Operation	56.815 W	56.054 W	57.984 W
Sleep (Energy Star low power mode)	2.319 W	2.626 W	2.296 W
Off	1.097 W	1.31 W	1.075 W
Heat Dissipation*	115 VAC	230 VAC	100 VAC
Normal Operation	194 BTU/hr	192 BTU/hr	198 BTU/hr
Sleep	8 BTU/hr	9 BTU/hr	7 BTU/hr
Off	4 BTU/hr	5 BTU/hr	4 BTU/hr

^{*} Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

This product is in compliance with US executive order 13221, WOL (wake on LAN) disabled.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)

	Sound Power	Sound Pressure
System Fan Off	(LWAd, bels)	(LpAm, decibels)
Idle	3.7	22
Fixed Disk	3.8	22
(random writes)		

Configuration with optional 10,000 rpm HDD

	Sound Power	Sound Pressure
System Fan Off	(LWAd, bels)	(LpAm, decibels)
Idle	3.9	21
Fixed Disk	4.4	25
(random writes)		

Batteries

This product complies with ISO standards:

- EU Directive 91/157/EEC
- EU Directive 93/86/EEC
- EU Directive 98/101/EEC



Technical Specifications - Environmental Data

Batteries used in the product do not contain:

- Mercury greater the 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 4000ppm by weight.

Battery size: CR2032 (coin cell)

Battery type: Lithium

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive 2002/95/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level¹, see www.epeat.net
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive 2002/96/EC.
- Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 0% recycled materials (by wt.)
- This product is 96.6% recyclable when properly disposed of at end of life.

Packaging Materials

- External:
 - Corrugated carbon 1687.37 g
 - O Polyethylene low density solid 63.5 g
- Internal:
 - EPE-Expanded Polyethylene 308 g
- The EPE foam packaging material is made from 0% recycled content.
- The corrugated paper packaging materials contains at least 25% recycled content.

¹ EPEAT certification is conditional upon ENERGY STAR qualification. Only dc7900e models which qualify for ENERGY STAR will be certified EPEAT – Gold.

Ultra-Slim Desktop, Small Form Factor, Convertible Minitower

RoHS Compliance

Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis. By July 1, 2006, RoHS substances will be virtually eliminated (virtually = to levels below legal limits) for all HP electronic products subject to the RoHS Directive, except where it is widely recognized that there is no technically feasible alternative (as indicated by an exemption under the EU RoHS Directive).

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the

Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins



Technical Specifications - Environmental Data

- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

and Recycling

End-of-life Management Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

> The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

Hewlett-Packard Corporate Environmental Global Citizenship Report Information

For more information about HP's commitment to the environment:

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html

ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html



Technical Specifications - Environmental Data

© Copyright 2011 Hewlett-Packard Development Company, L.P. The information contained herein is subject to change without notice.

Intel and Pentium are U.S. registered trademarks of Intel Corporation. Microsoft and Windows are U.S. registered trademarks of Microsoft Corporation. The only warranties for HP products and services are set forth in the express warranty statements accompanying such products and services. Nothing herein should be construed as constituting an additional warranty. HP shall not be liable for technical or editorial errors or omissions contained herein.

